



PROTON-ELECTROTEX RUSSIA

Low switching losses
Low reverse recovery charge
Distributed amplified gate for high di_T/dt

Fast Thyristor Type TFI773-2000-25

Maximum allowable mean on-state current			I _{TAV}		2000 A	
Repetitive peak off-state voltage			V _{DRM}		2000...2500 V	
Repetitive peak reverse voltage			V _{RRM}			
Turn-off time			t _q		40.0, 50.0, 63.0 μs	
V _{DRM} , V _{RRM} , V	2000	2200	2400		2500	
Voltage code	20	22	24		25	
T _j , °C	-60...+125					

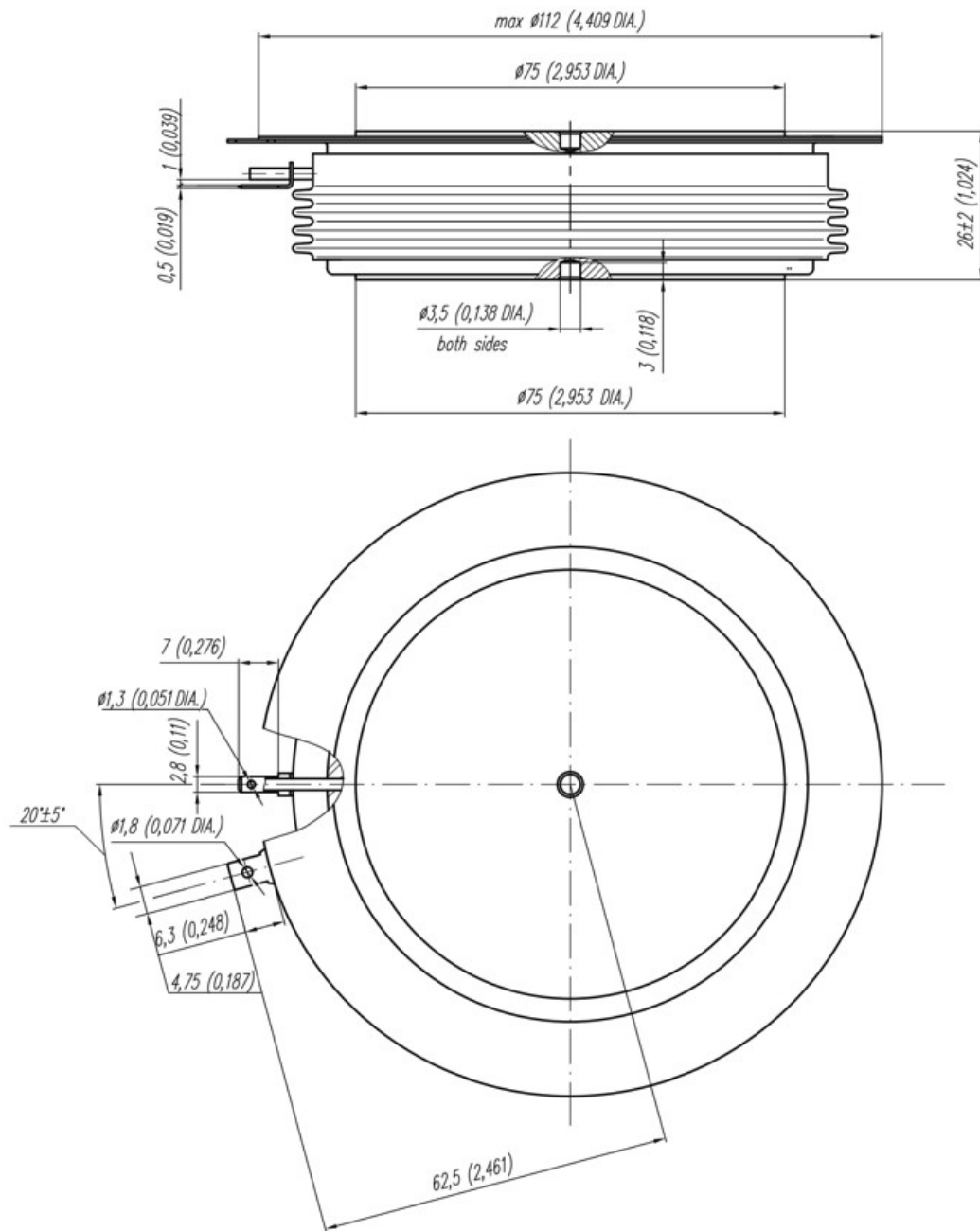
MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Maximum allowable mean on-state current	A	2000 2249 3315	$T_c=91\text{ }^{\circ}\text{C}$; Double side cooled; $T_c=85\text{ }^{\circ}\text{C}$; Double side cooled; $T_c=55\text{ }^{\circ}\text{C}$; Double side cooled; 180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current	A	3140	$T_c=91\text{ }^{\circ}\text{C}$; Double side cooled; 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current	kA	45.0 52.0	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p=10\text{ ms}$; single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=I_{FGM}$; $V_G=20\text{ V}$; $t_{GP}=50\text{ }\mu\text{S}$; $di_G/dt=2\text{ A}/\mu\text{S}$
			47.0 54.0	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p=8.3\text{ ms}$; single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=I_{FGM}$; $V_G=20\text{ V}$; $t_{GP}=50\text{ }\mu\text{S}$; $di_G/dt=2\text{ A}/\mu\text{S}$
I^2t	Safety factor	$A^2s\cdot 10^3$	10100 13500	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p=10\text{ ms}$; single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=I_{FGM}$; $V_G=20\text{ V}$; $t_{GP}=50\text{ }\mu\text{S}$; $di_G/dt=2\text{ A}/\mu\text{S}$
			9100 12100	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p=8.3\text{ ms}$; single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=I_{FGM}$; $V_G=20\text{ V}$; $t_{GP}=50\text{ }\mu\text{S}$; $di_G/dt=2\text{ A}/\mu\text{S}$
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	2000...2500	$T_{j\text{ min}} < T_j < T_{j\text{ max}}$; 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	2100...2600	$T_{j\text{ min}} < T_j < T_{j\text{ max}}$; 180° half-sine wave; single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.6\cdot V_{DRM}$ $0.6\cdot V_{RRM}$	$T_j=T_{j\text{ max}}$; Gate open	

TRIGGERING				
I_{FGM}	Peak forward gate current	A	10	$T_j = T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	8	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	2500	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; $I_{TM} = 8000$ A; Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	$^{\circ}$ C	-60...+50	
T_j	Operating junction temperature	$^{\circ}$ C	-60...+125	
MECHANICAL				
F	Mounting force	kN	40.0...50.0	
a	Acceleration	m/s ²	50	Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions		
ON-STATE						
V _{TM}	Peak on-state voltage, max	V	2.15	T _j =25 °C; I _{TM} =6280 A		
V _{T(TO)}	On-state threshold voltage, max	V	1.265	T _j =T _{j max} ;		
r _T	On-state slope resistance, max	mΩ	0.150	0.5 π I _{TAV} < I _T < 1.5 π I _{TAV}		
I _H	Holding current, max	mA	1000	T _j =25 °C; V _D =12 V; Gate open		
BLOCKING						
I _{DRM} , I _{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	T _j =T _{j max} ; V _D =V _{DRM} ; V _R =V _{RRM}		
(dv _D /dt) _{crit}	Critical rate of rise of off-state voltage ¹⁾ , min	V/μs	200, 320, 500, 1000, 1600, 2000, 2500	T _j =T _{j max} ; V _D =0.67·V _{DRM} ; Gate open		
TRIGGERING						
V _{GT}	Gate trigger direct voltage, max	V	3.00 3.00 1.50	T _j = T _{j min} T _j =25 °C T _j = T _{j max}	V _D =12 V; I _D =3 A; Direct gate current	
I _{GT}	Gate trigger direct current, max	mA	500 300 150	T _j = T _{j min} T _j = 25 °C T _j = T _{j max}		
V _{GD}	Gate non-trigger direct voltage, min	V	0.35	T _j =T _{j max} ; V _D =0.67·V _{DRM} ;		
I _{GD}	Gate non-trigger direct current, min	mA	70.00	Direct gate current		
SWITCHING						
t _{gd}	Delay time, max	μs	1.10	T _j =25 °C; V _D =1000 V; I _{TM} =I _{TAV} ; di/dt=200 A/μs;		
t _{gt}	Turn-on time ²⁾ , max	μs	2.50, 3.20, 4.00, 6.30	Gate pulse: I _G =2 A; V _G =20 V; t _{GP} =50 μs; di _G /dt=2 A/μs		
t _q	Turn-off time ³⁾ , max	μs	40.0, 50.0, 63.0	dv _D /dt=50 V/μs;	T _j =T _{j max} ; I _{TM} = I _{TAV} ; di _R /dt=-10 A/μs; V _R =100V; V _D =0.67 V _{DRM}	
			50.0, 63.0, 80.0	dv _D /dt=200 V/μs;		
Q _{rr}	Recovered charge, max	μC	1250	T _j =T _{j max} ; I _{TM} =1000 A;		
t _{rr}	Reverse recovery time, max	μs	10	di _R /dt=-50 A/μs;		
I _{rr}	Reverse recovery current, max	A	250	V _R =100 V		



All dimensions in millimeters (inches)

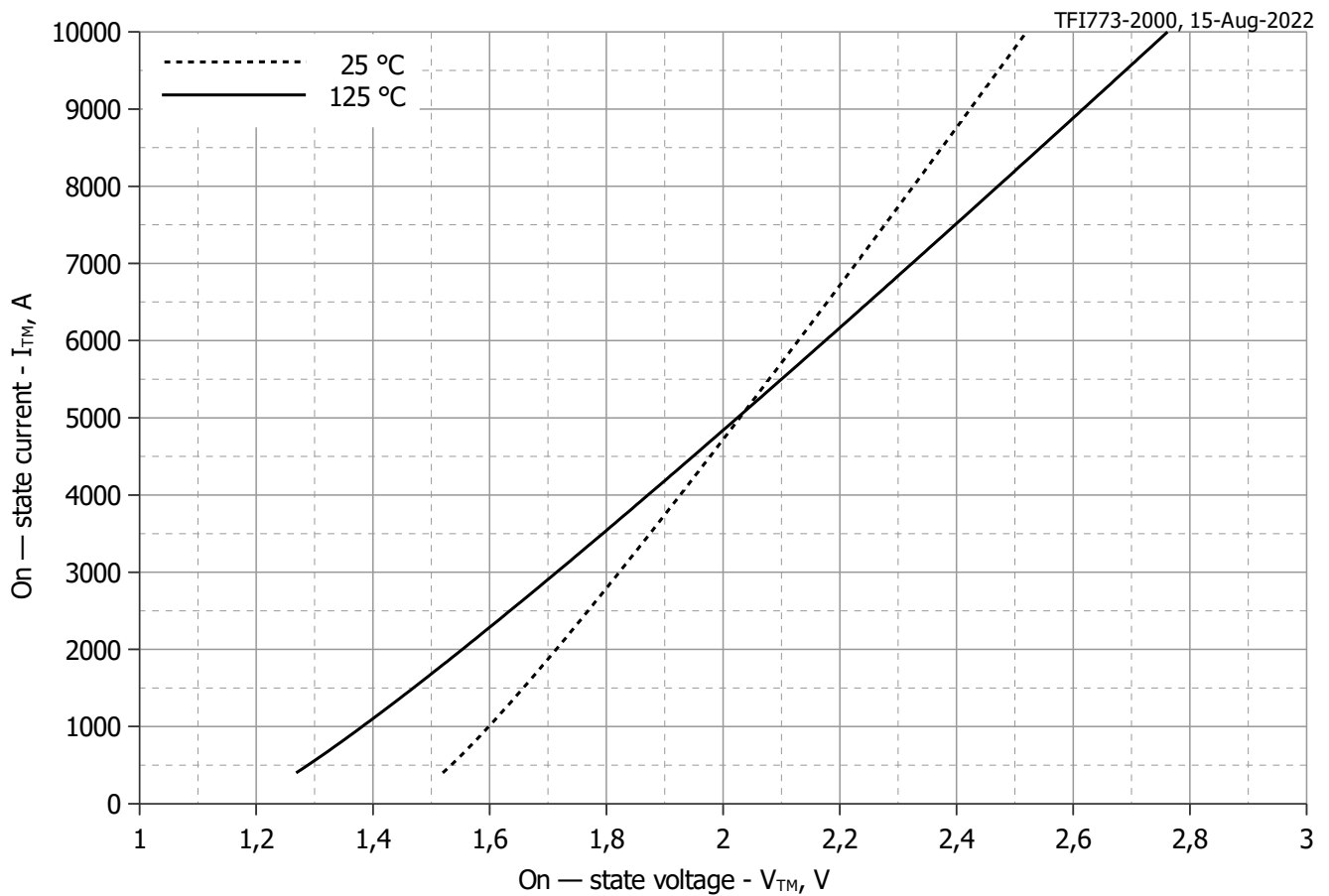


Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j\max}$
A	1.42507441	1.19417755
B	0.00008531	0.00012521
C	0.00289066	-0.00939487
D	0.00215361	0.00402084

On-state characteristic model (see Fig. 1).

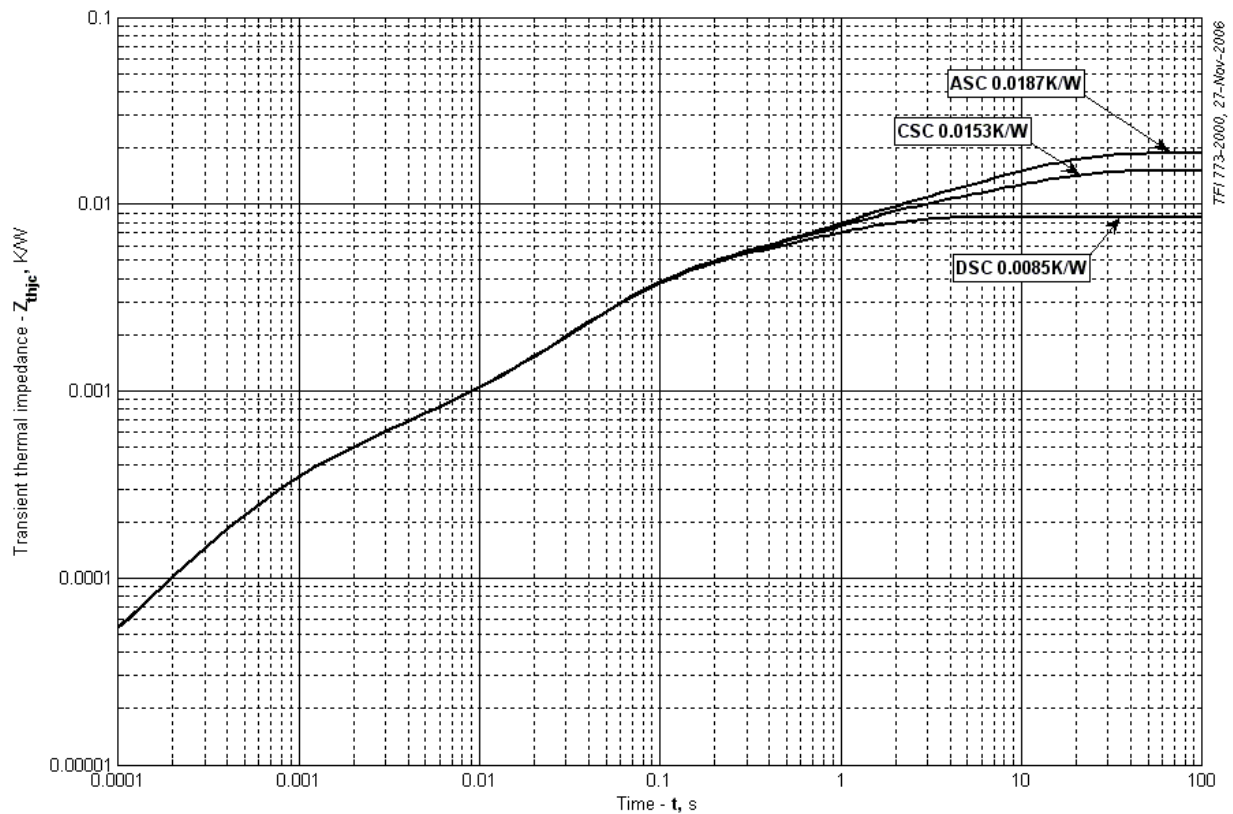


Fig 2 – Transient thermal impedance Z_{thjc} vs. time t

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t .

R_i = Amplitude of p_{th} term.

τ_i = Time constant of r_{th} term.

DC Double side cooled

i	1	2	3	4	5	6
R_i , K/W	0.00005221	0.002783	0.0002688	0.001171	0.0002371	0.003988
τ_i , s	1.920	0.06256	0.002215	0.120	0.0006005	0.9534

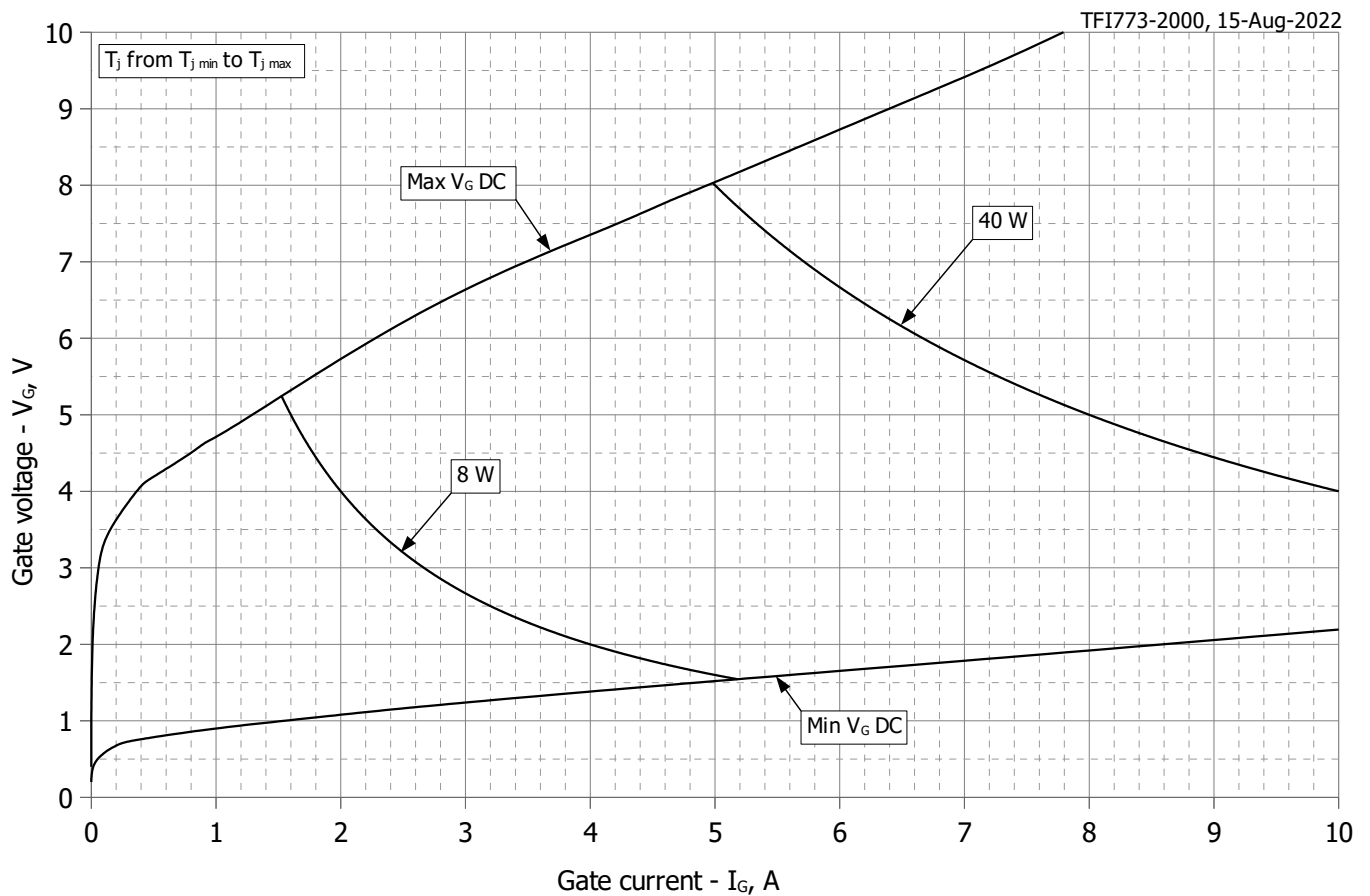
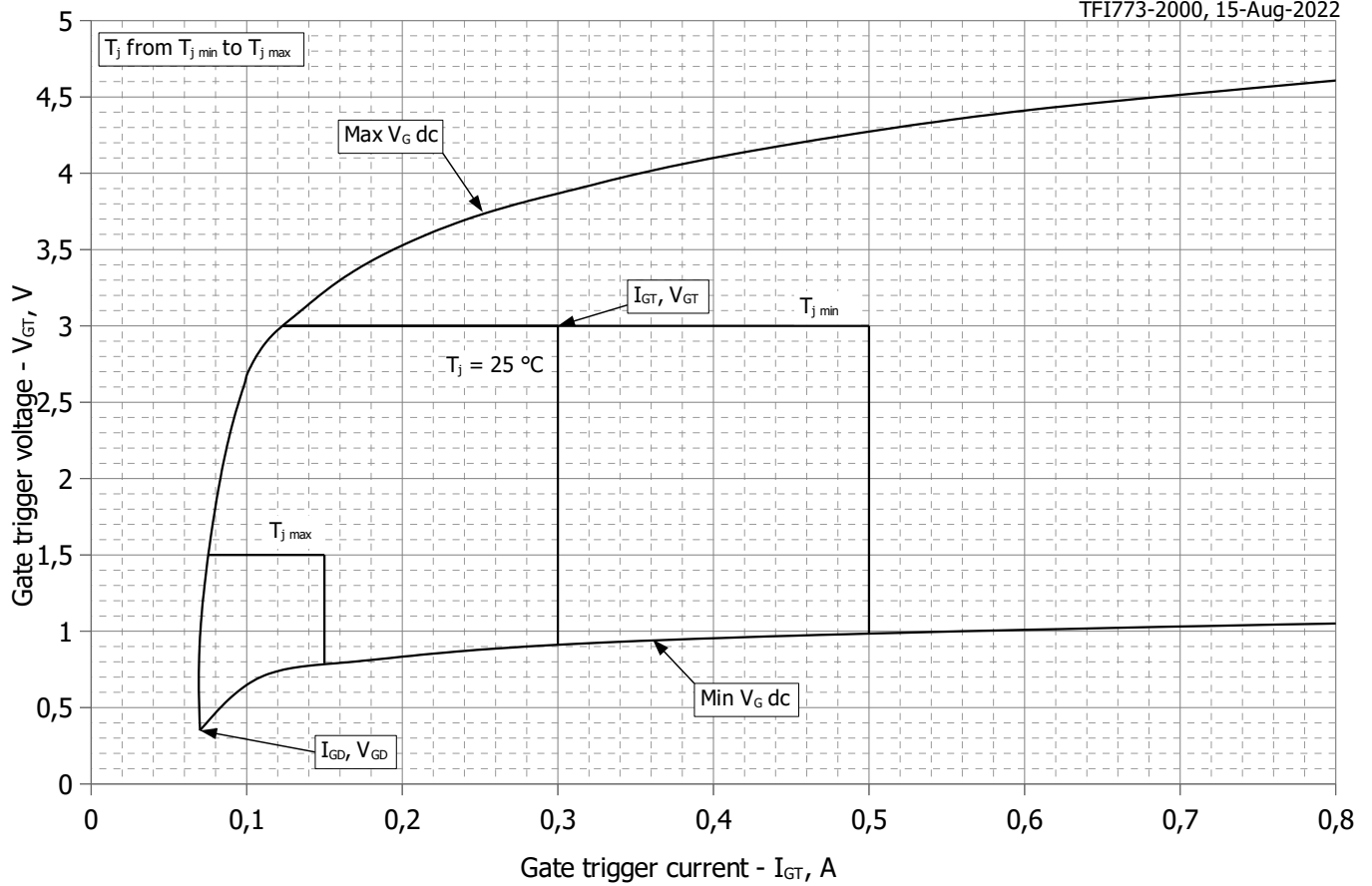
DC Anode side cooled

i	1	2	3	4	5	6
R_i , K/W	0.01013	0.004065	0.001093	0.002843	0.0002657	0.0002413
τ_i , s	9.747	1.057	0.1241	0.06353	0.002255	0.0006066

DC Cathode side cooled

i	1	2	3	4	5	6
R_i , K/W	0.00662	0.004037	0.000959	0.002999	0.0002632	0.0002447
τ_i , s	9.743	1.024	0.1336	0.06442	0.002287	0.0006116

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2).



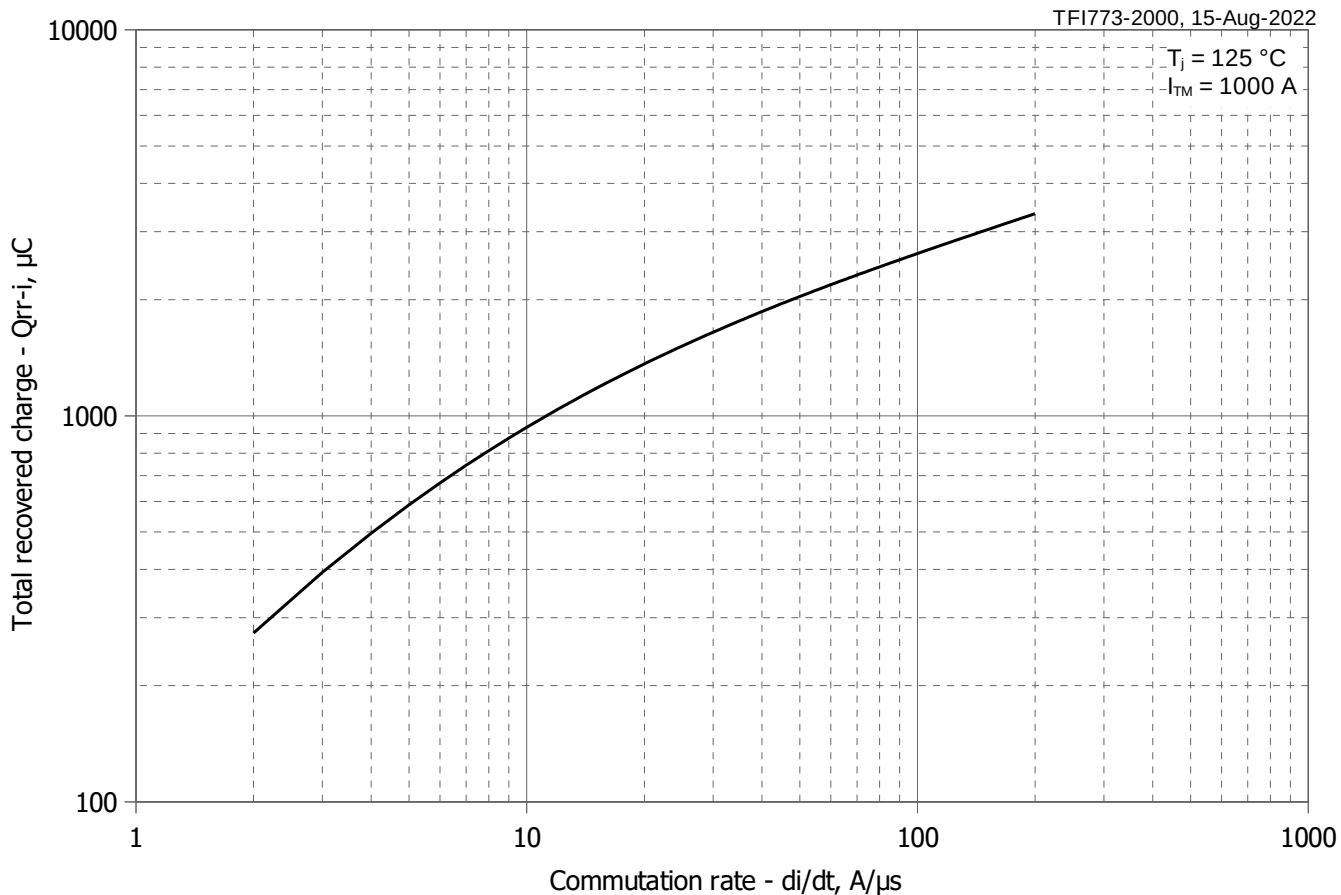


Fig 5 – Maximum recovered charge Q_{rr-i} (integral) vs. commutation rate di_R/dt

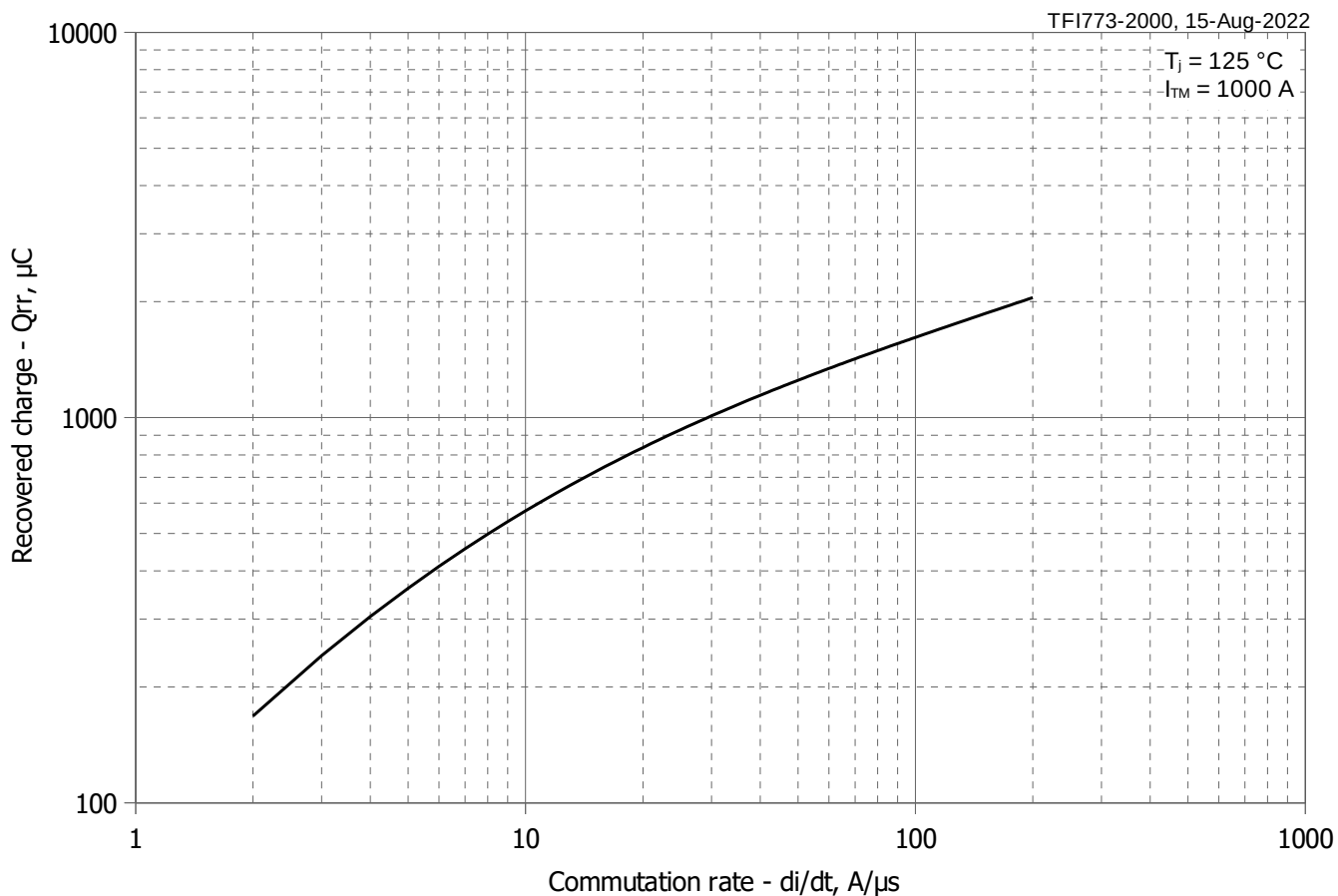


Fig 6 – Maximum recovered charge Q_{rr} vs. commutation rate di_R/dt (25% chord)

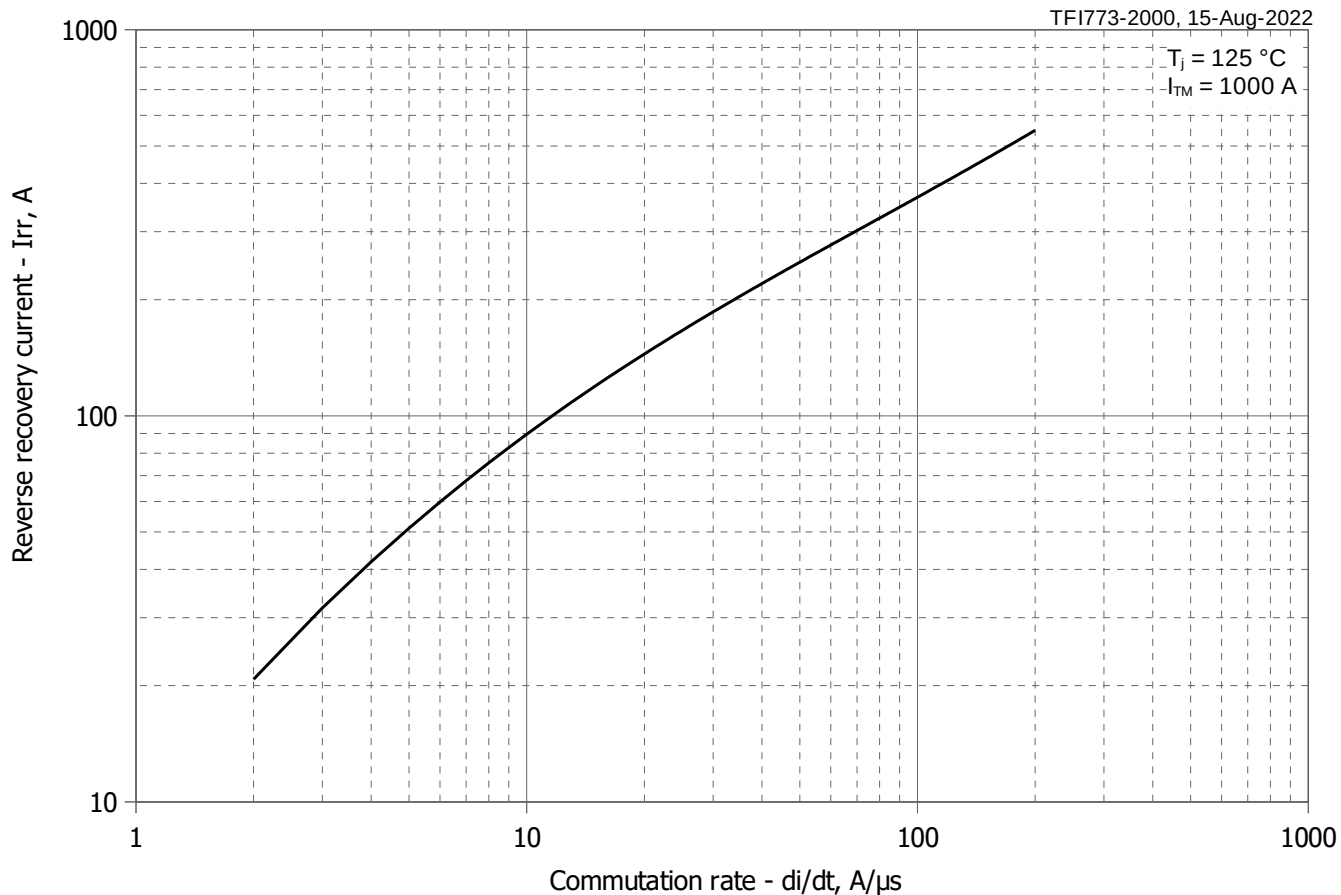


Fig 7 – Maximum reverse recovery current I_{rr} vs. commutation rate di_R/dt

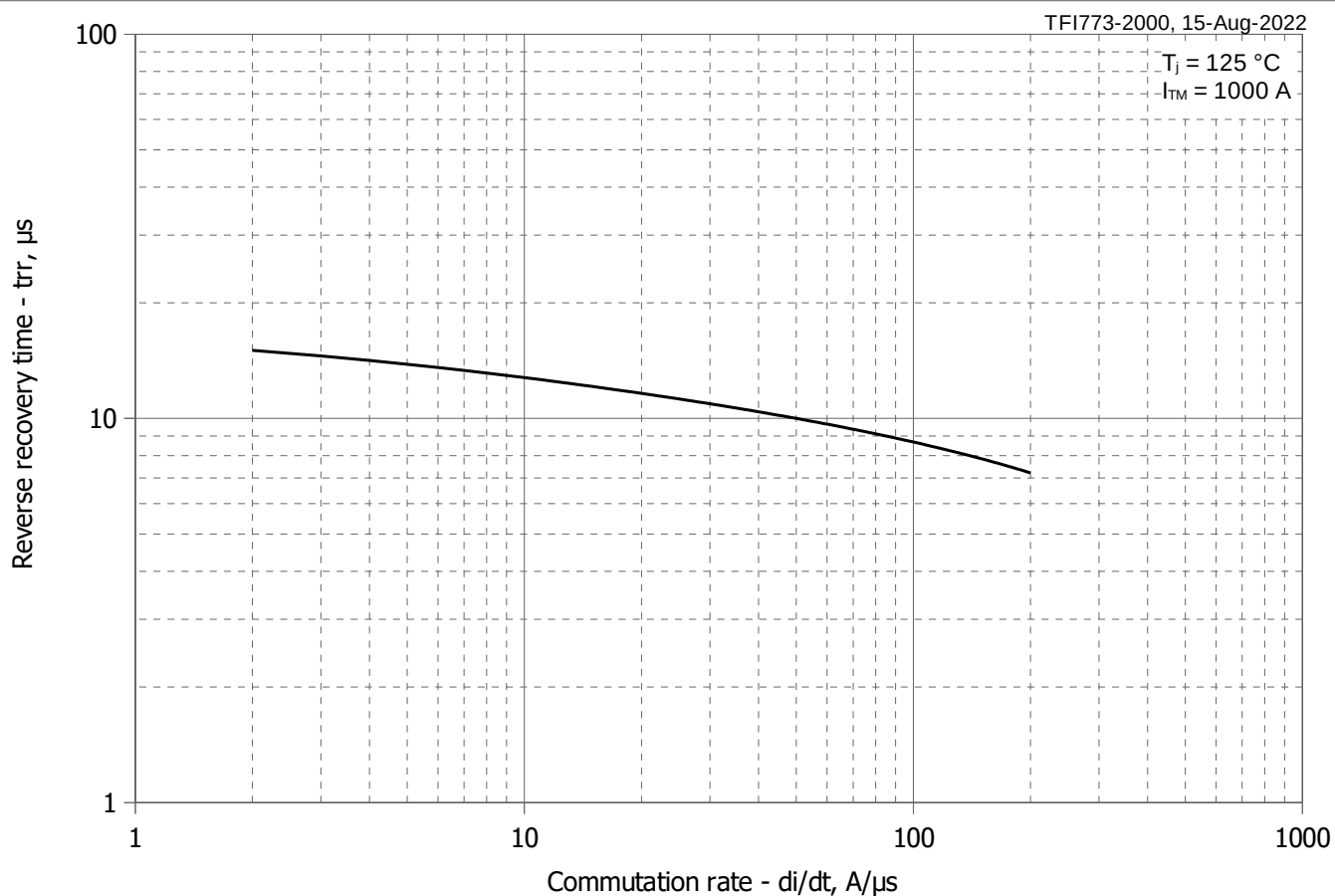


Fig 8 – Maximum recovery time t_{rr} vs. commutation rate di_R/dt (25% chord)

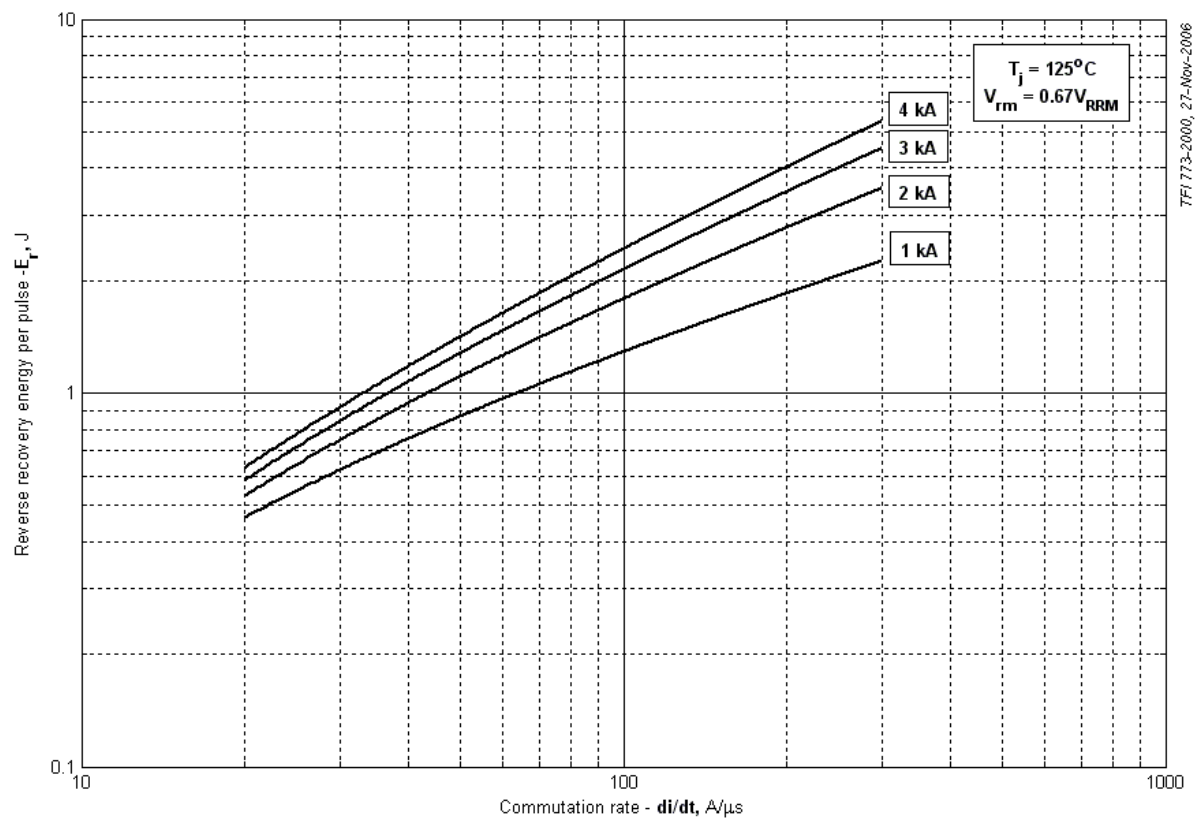


Fig 9 – Reverse recovery energy per pulse

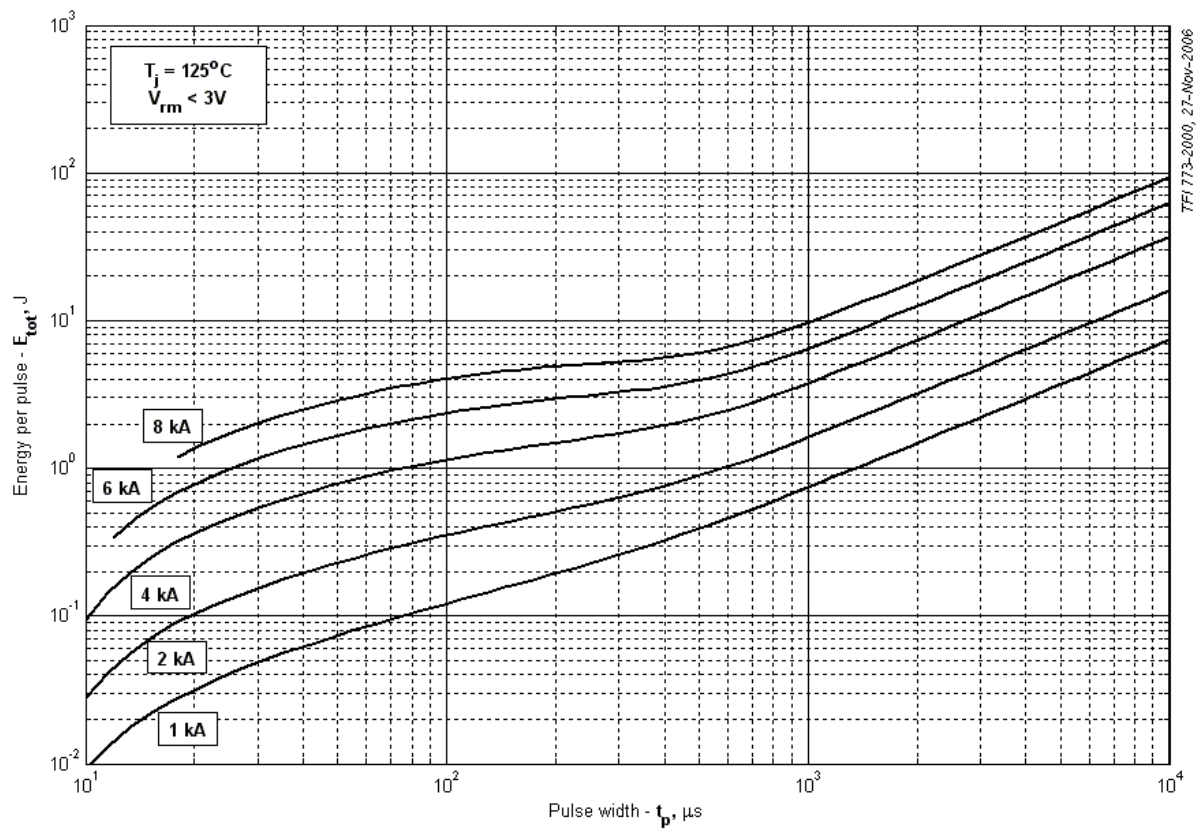


Fig 10 – Sine wave energy per pulse

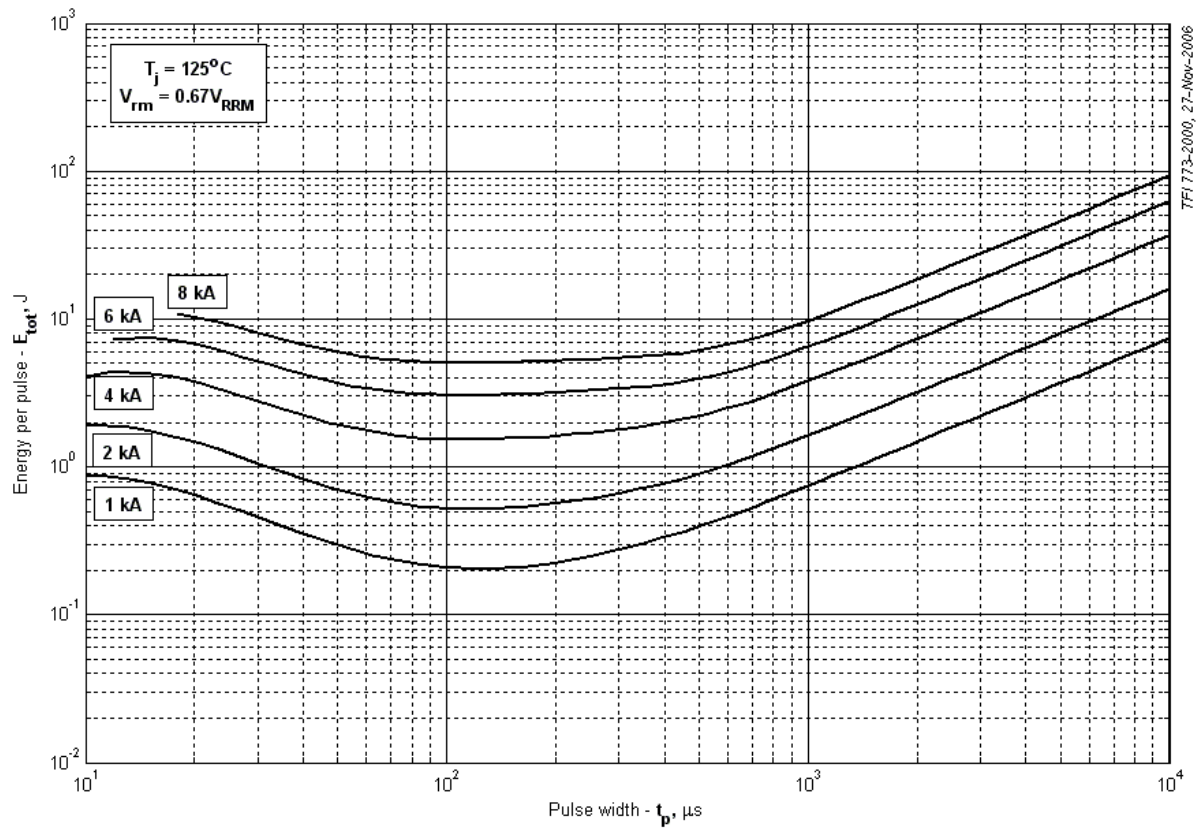


Fig 11 – Sine wave energy per pulse

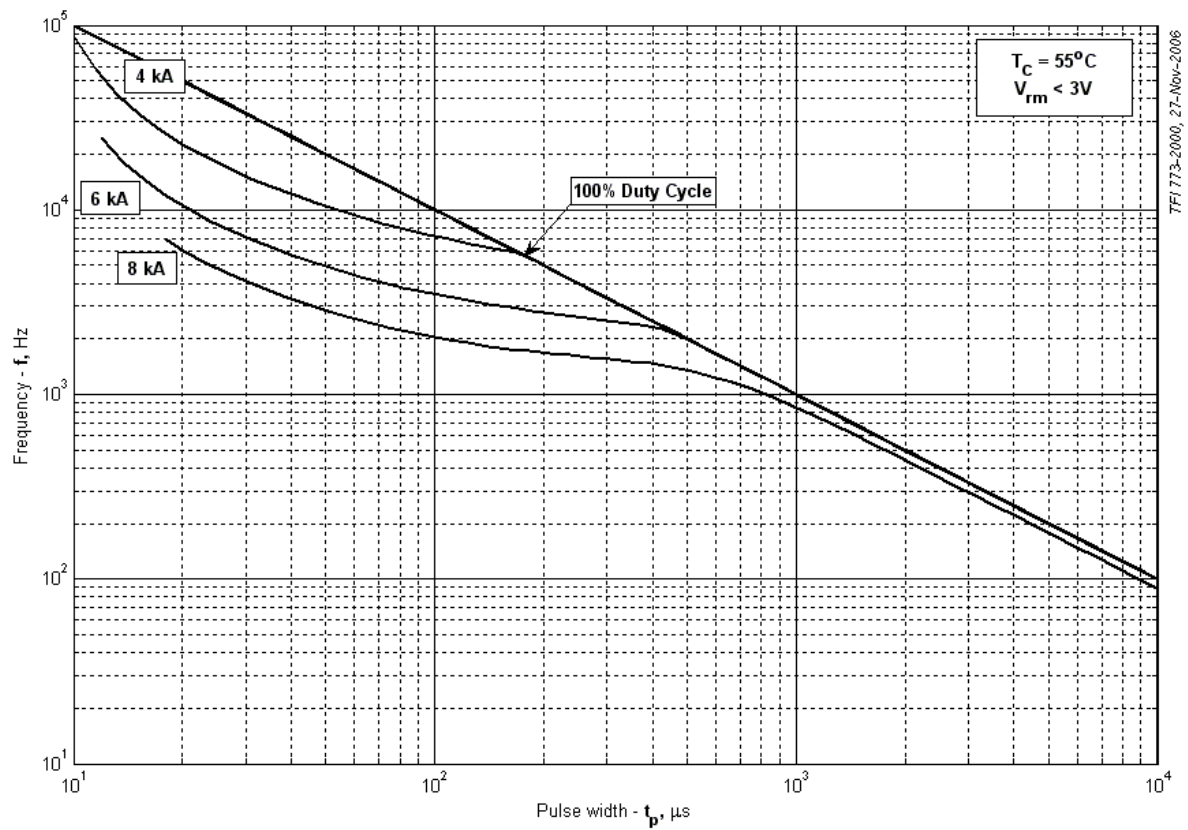


Fig 12 – Sine wave frequency ratings

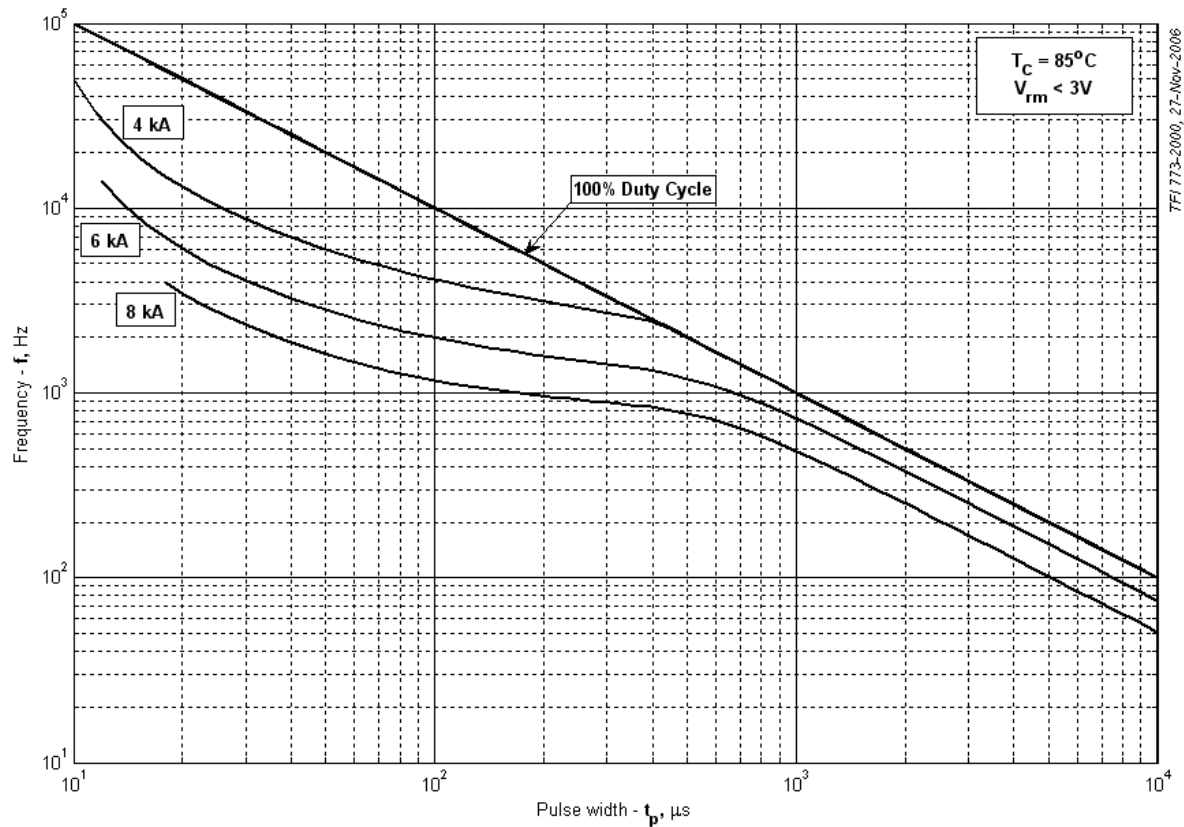


Fig 13 – Sine wave frequency ratings

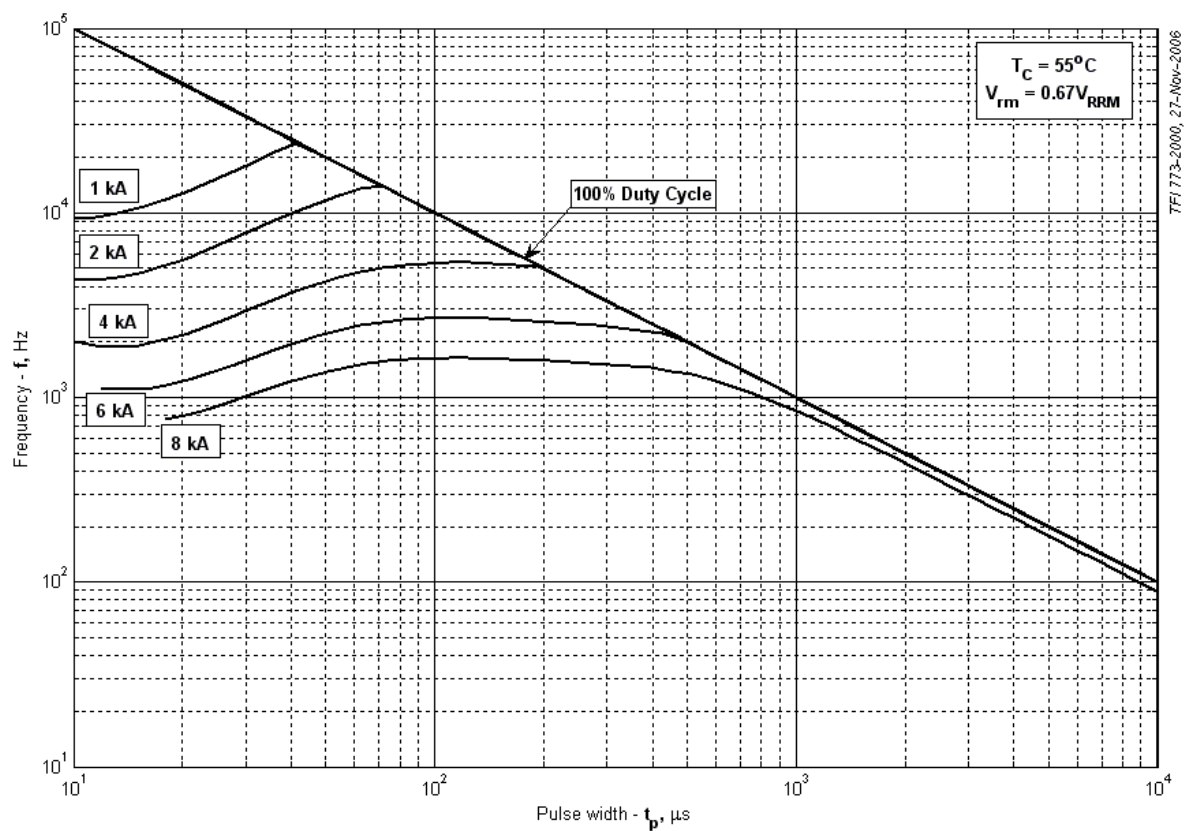


Fig 14 – Sine wave frequency ratings

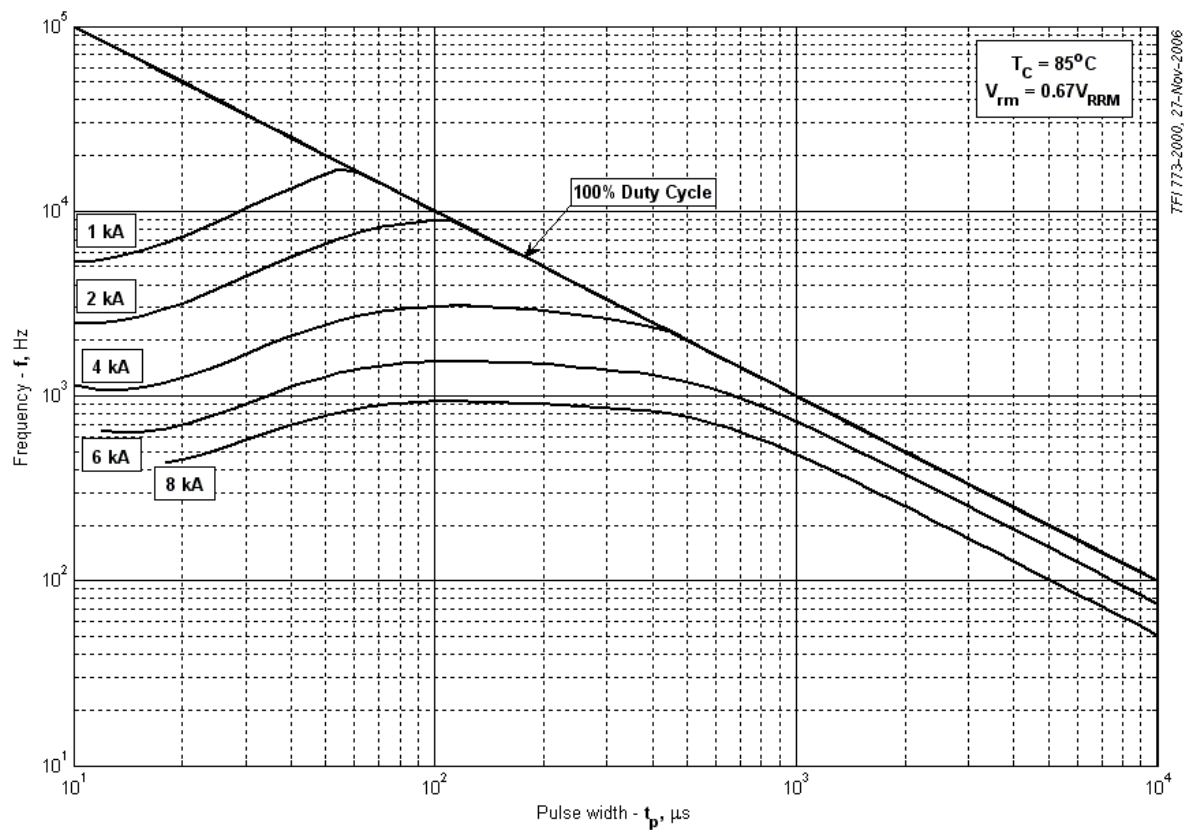


Fig 15 – Sine wave frequency ratings

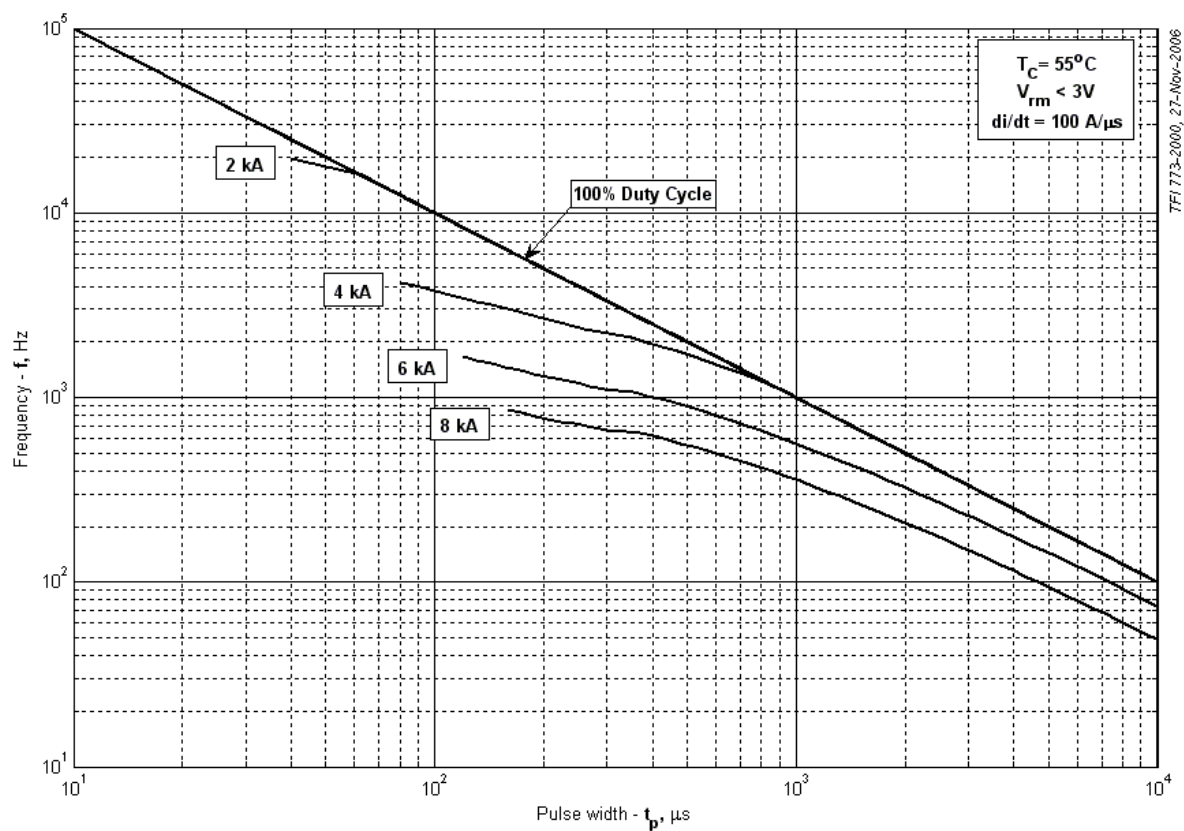


Fig 16 – Square wave frequency ratings

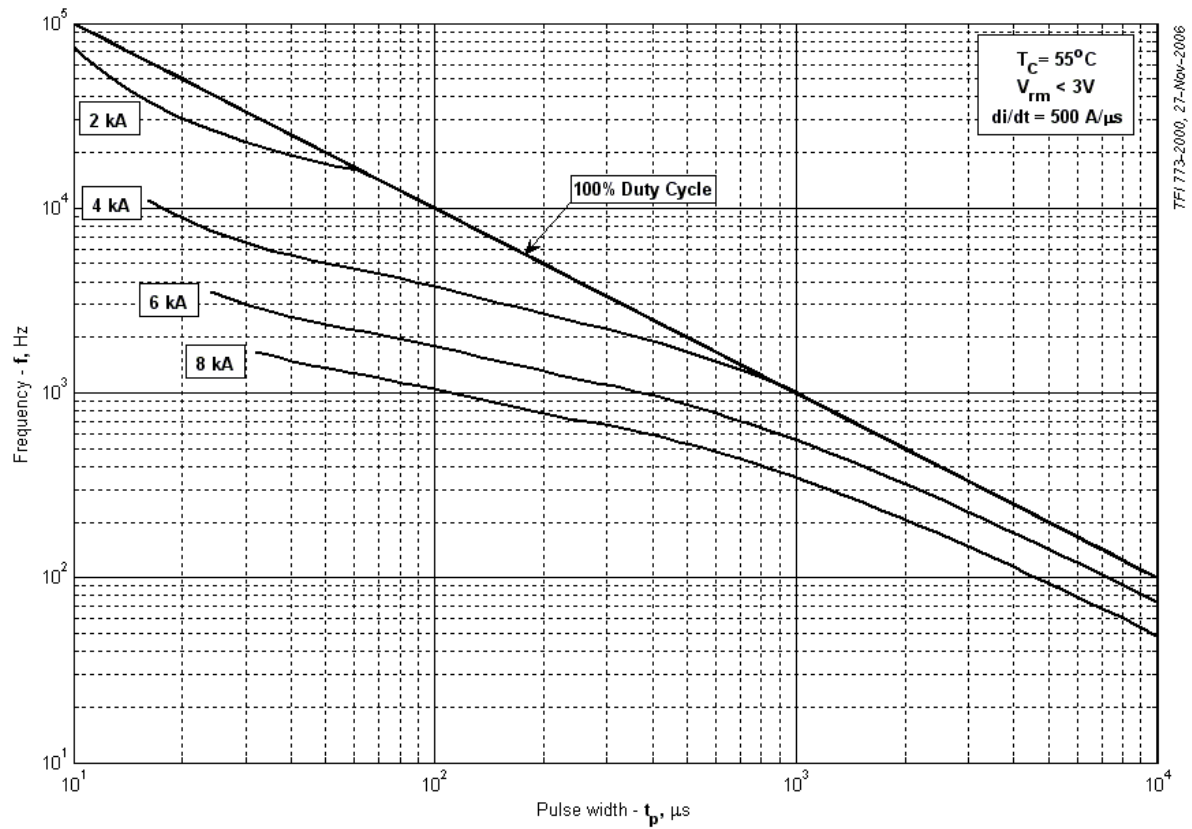


Fig 17 – Square wave frequency ratings

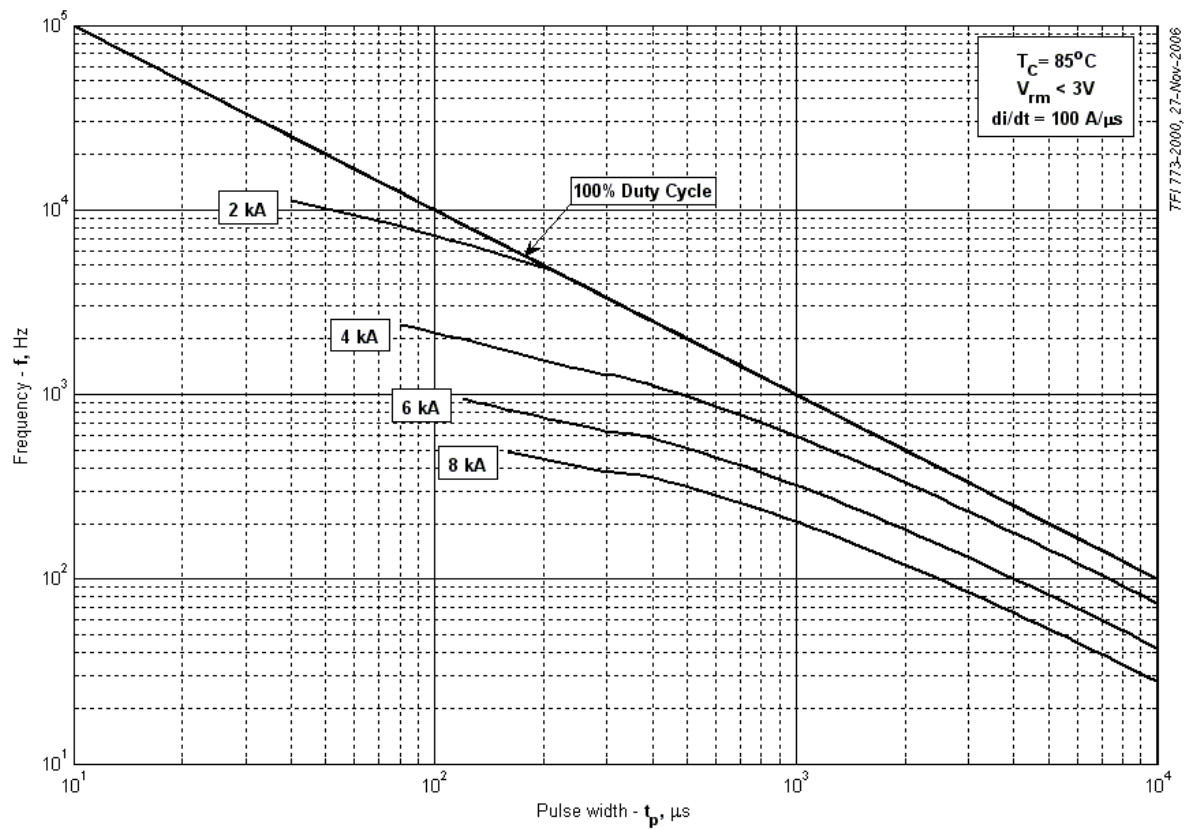


Fig 18 – Square wave frequency ratings

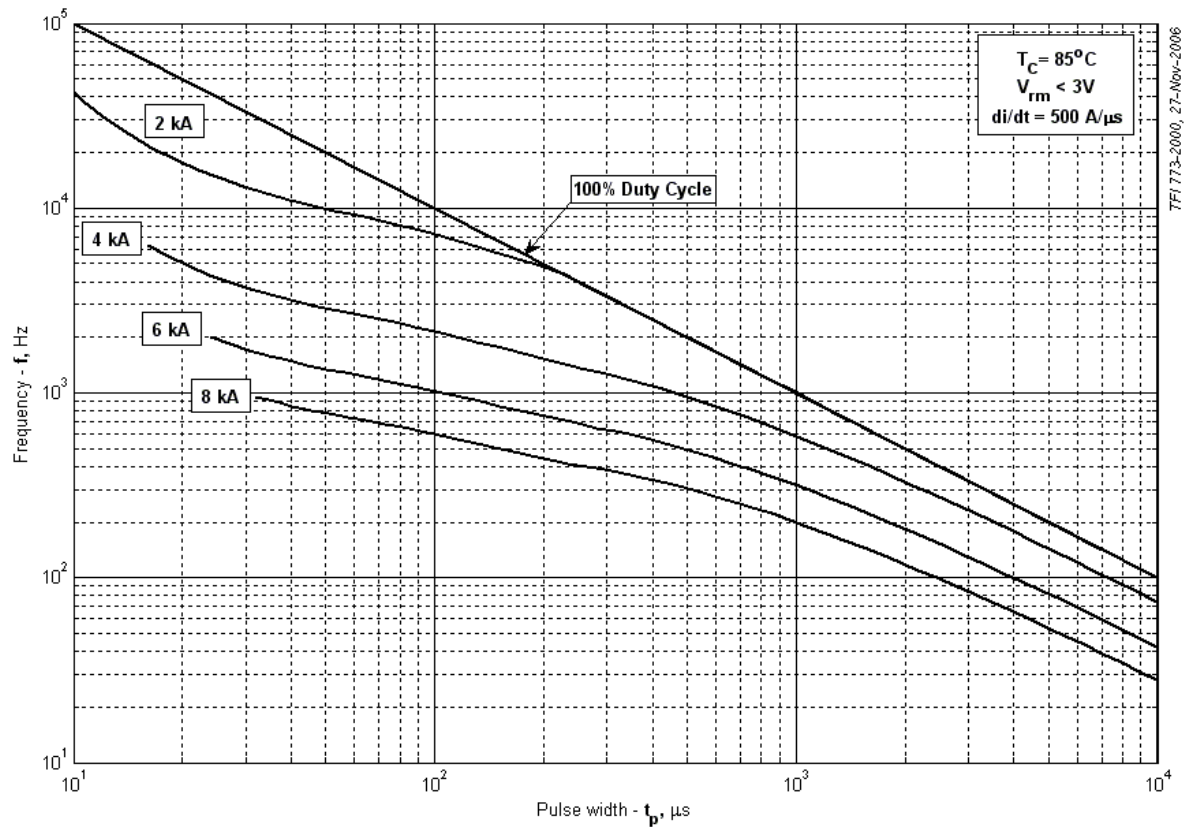


Fig 19 – Square wave frequency ratings

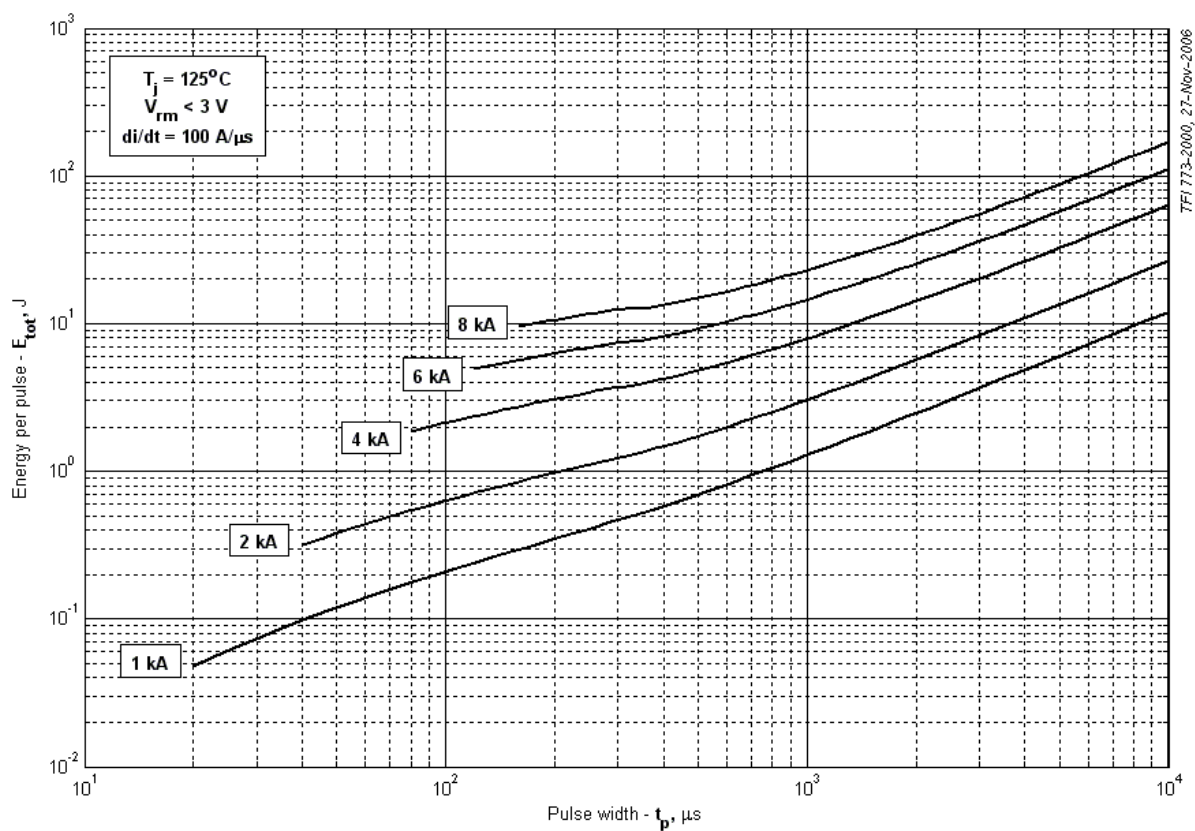


Fig 20 – Square wave energy per pulse

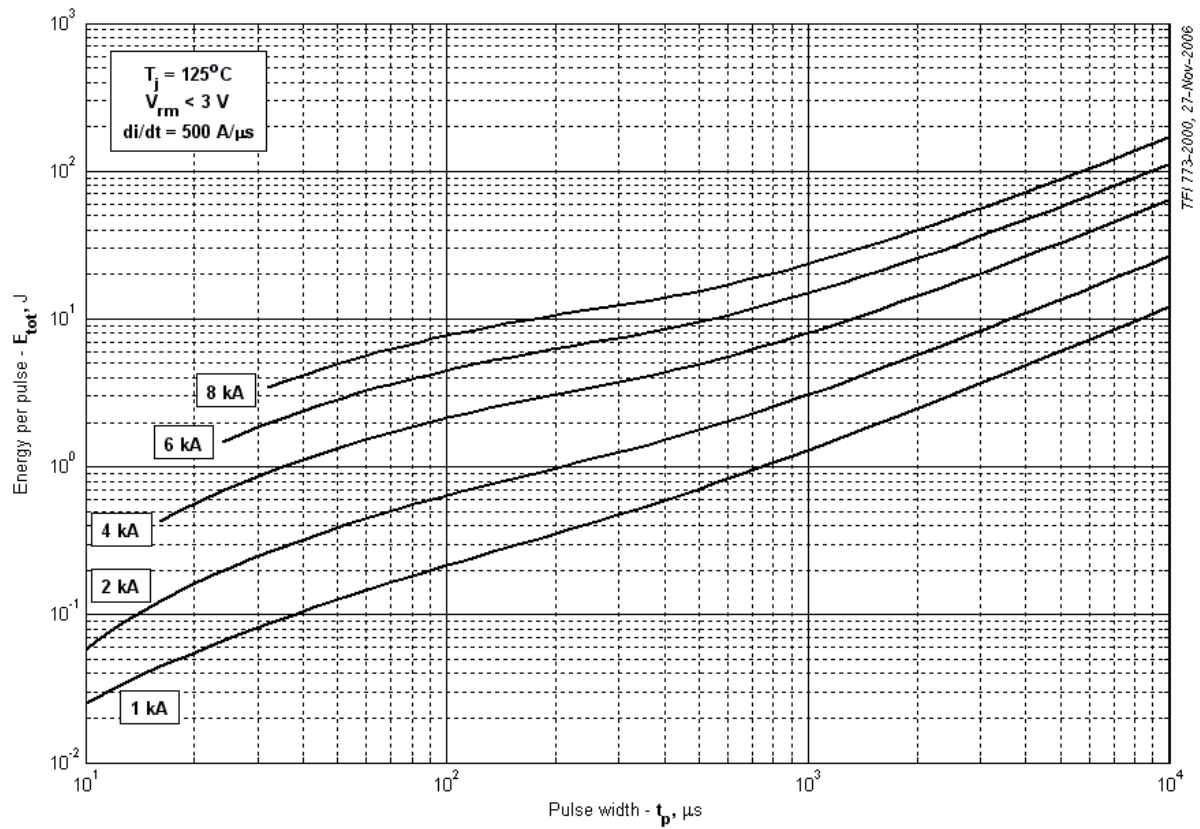


Fig 21 – Square wave energy per pulse

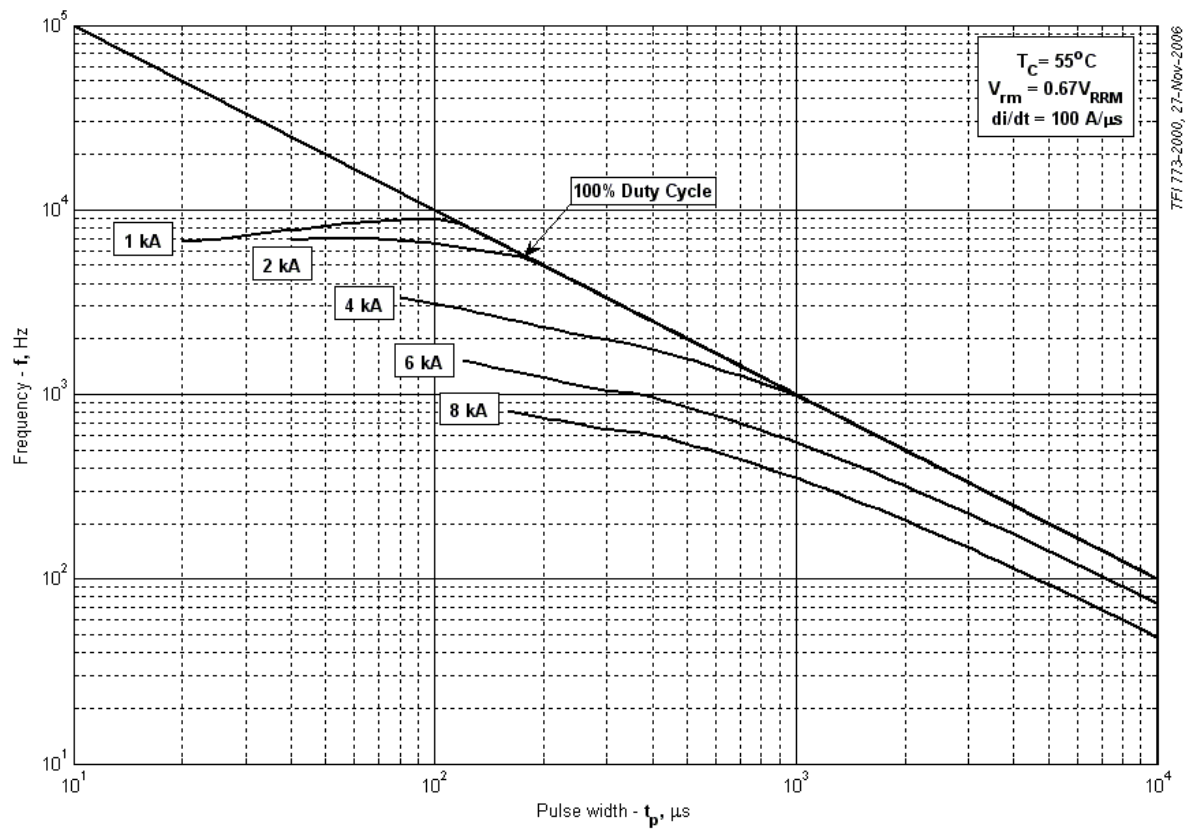


Fig 22 – Square wave frequency ratings

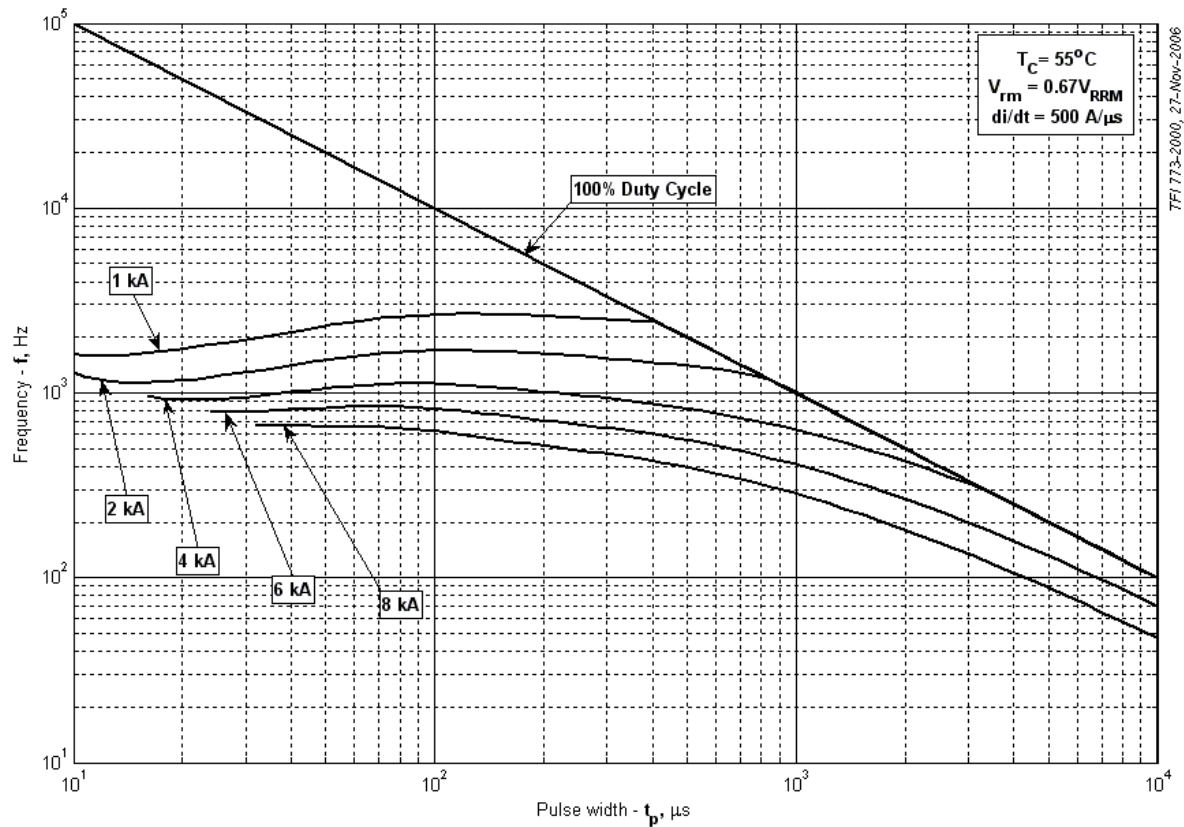


Fig 23 – Square wave frequency ratings

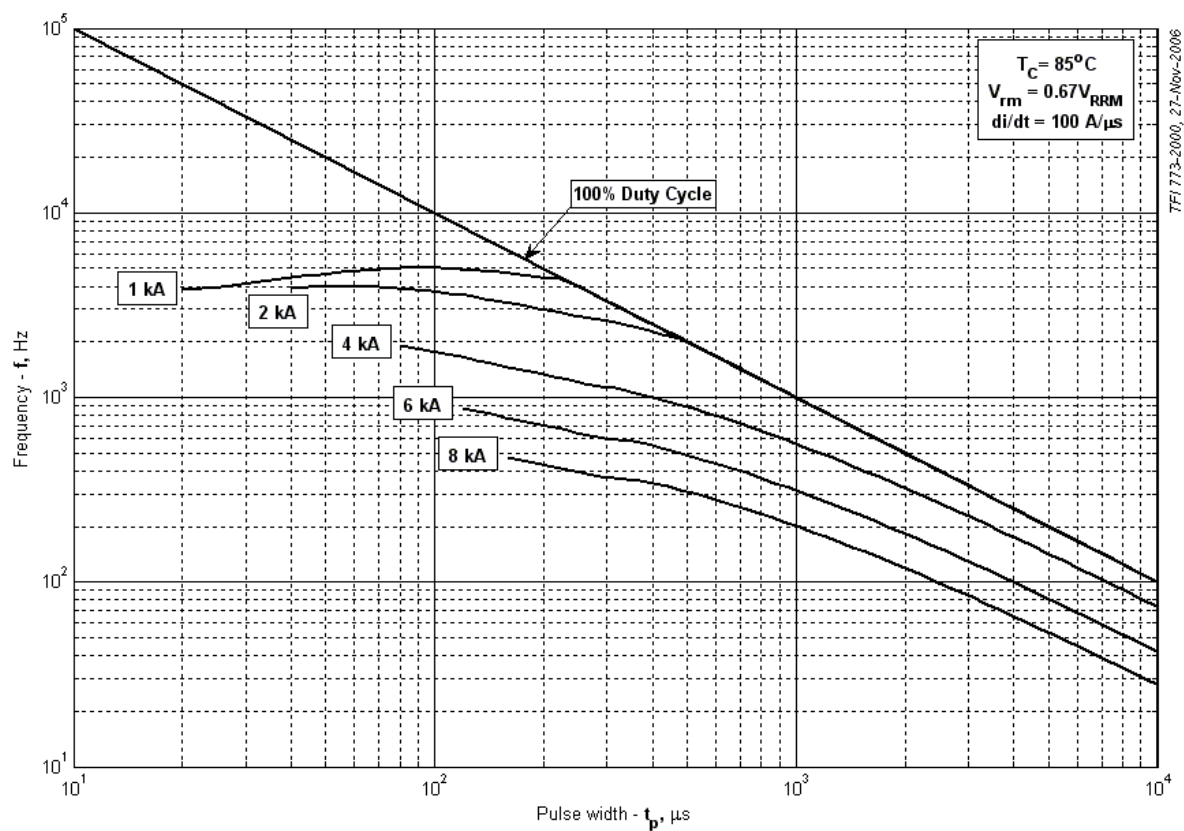


Fig 24 – Square wave frequency ratings

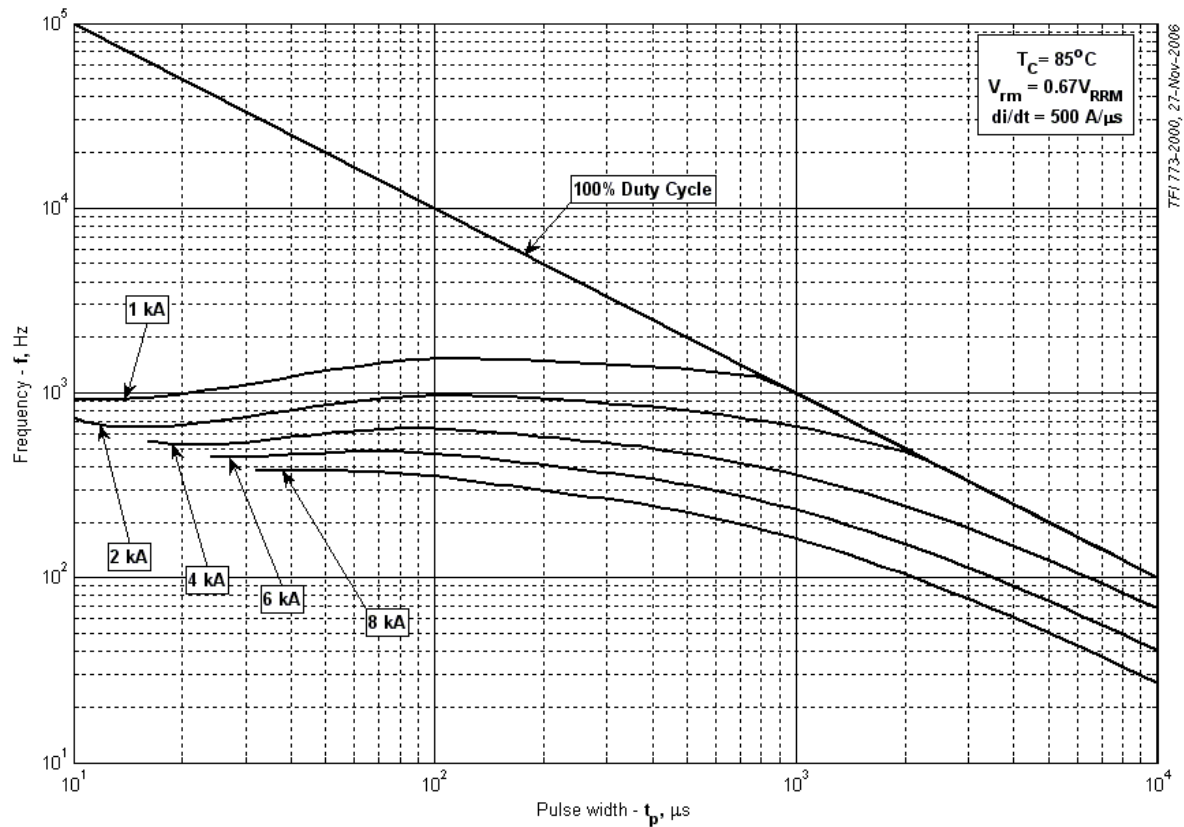


Fig 25 – Square wave frequency ratings

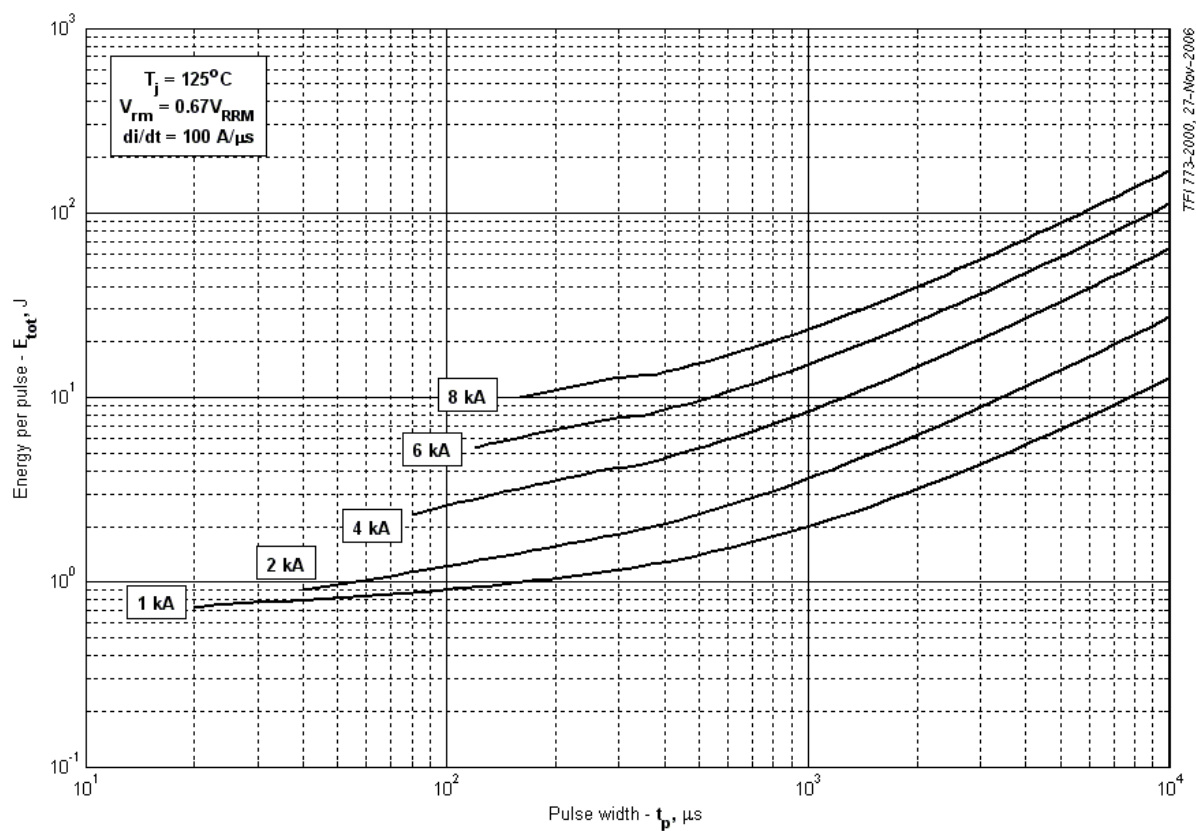


Fig 26 – Square wave energy per pulse

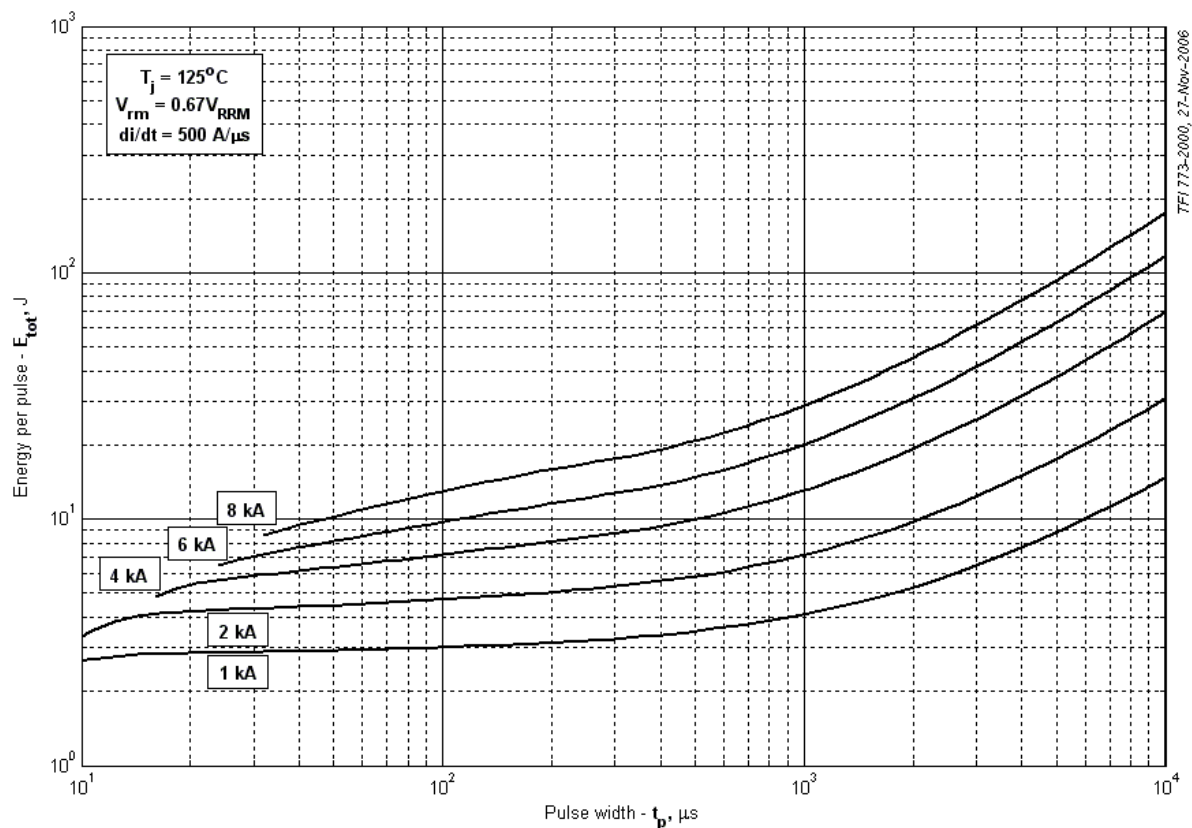


Fig 27 – Square wave energy per pulse

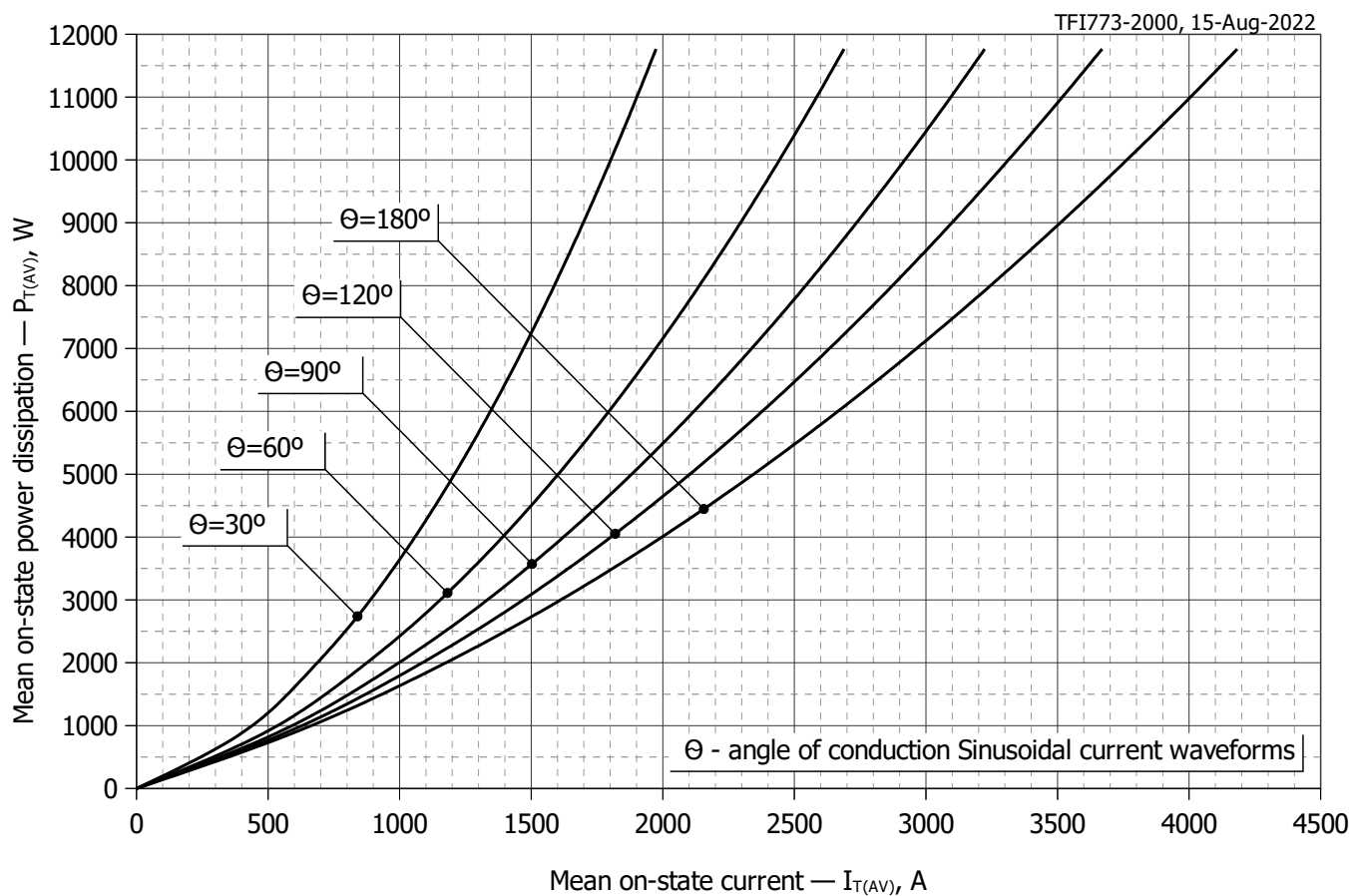


Fig 28 - Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for sinusoidal current waveforms at different conduction angles ($f=50\text{Hz}$, DSC)

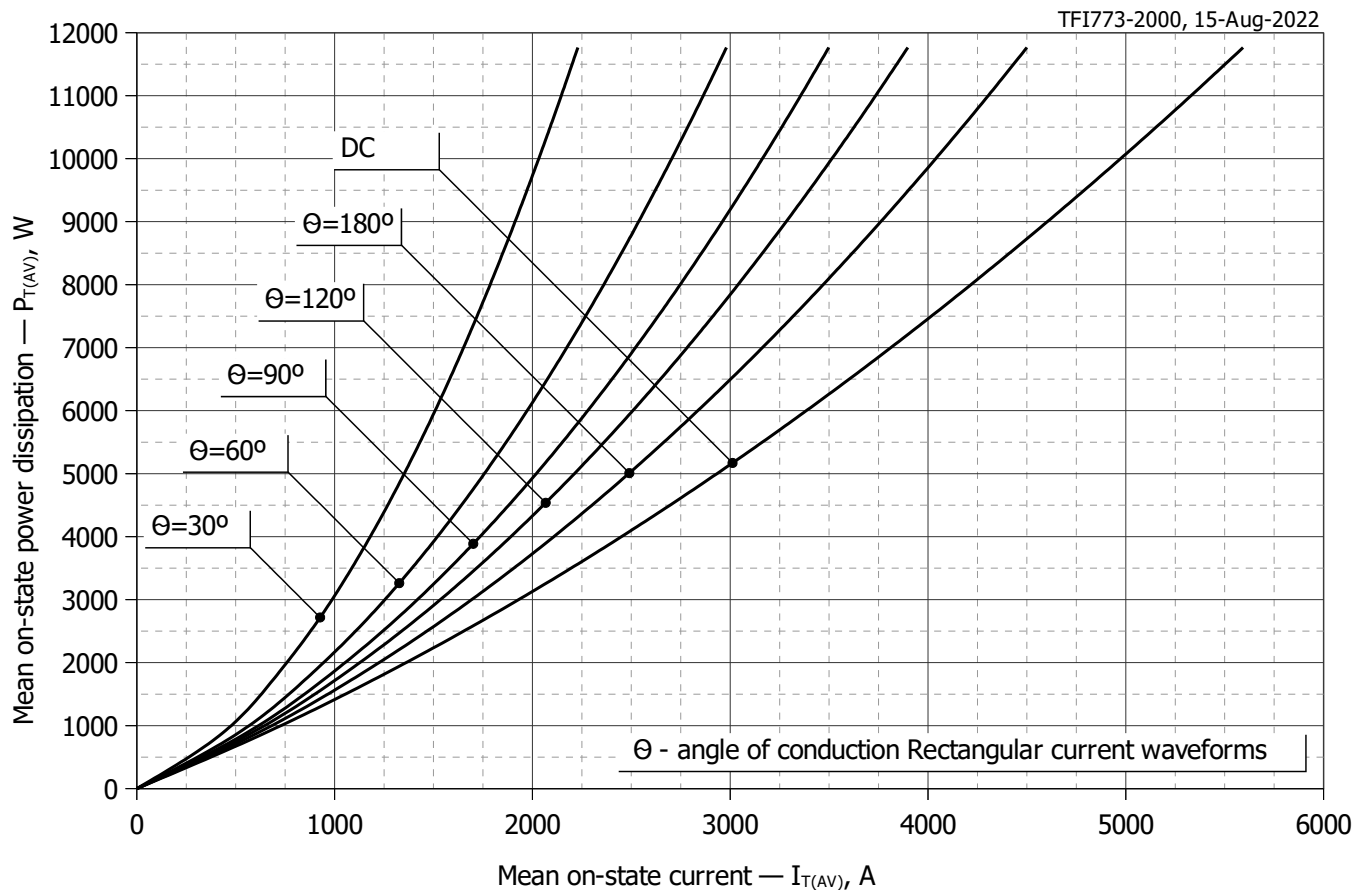


Fig 29 – Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for rectangular current waveforms at different conduction angles and for DC ($f=50\text{Hz}$, DSC)

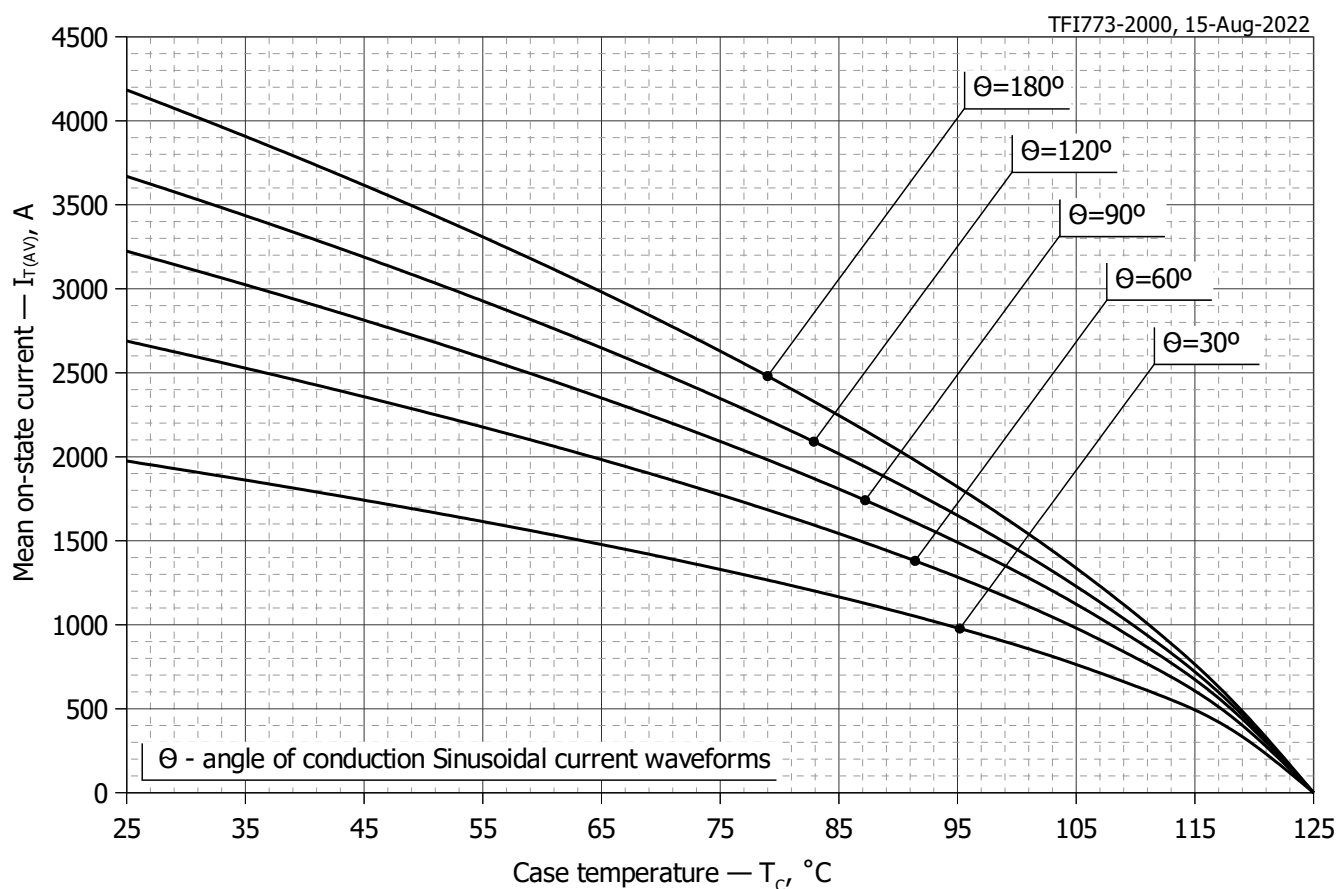


Fig 30 – Mean on-state current I_{TAV} vs. case temperature T_c for sinusoidal current waveforms at different conduction angles ($f=50\text{Hz}$, DSC)

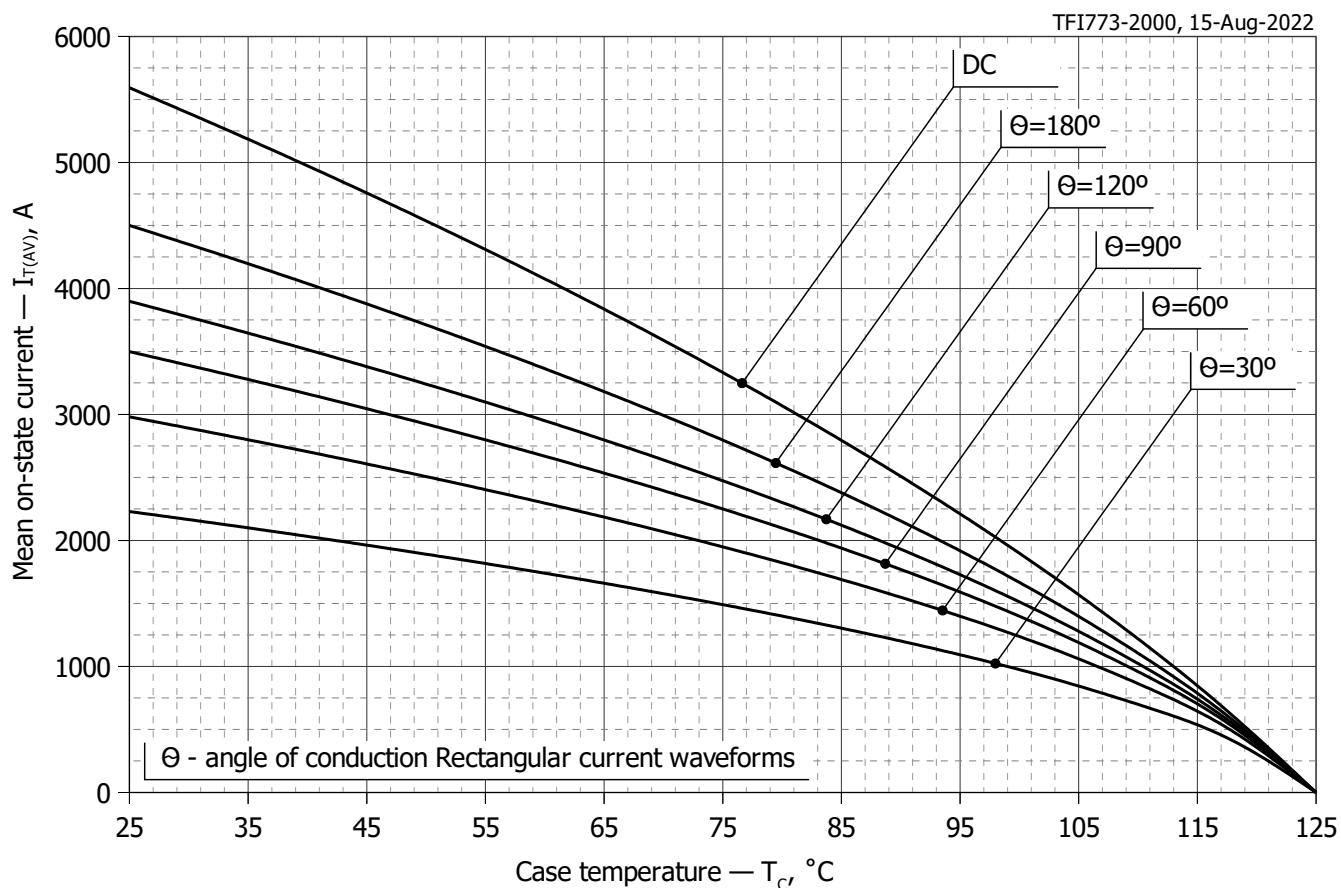


Fig 31 - Mean on-state current I_{TAV} vs. case temperature T_C for rectangular current waveforms at different conduction angles and for DC ($f=50\text{Hz}$, DSC)

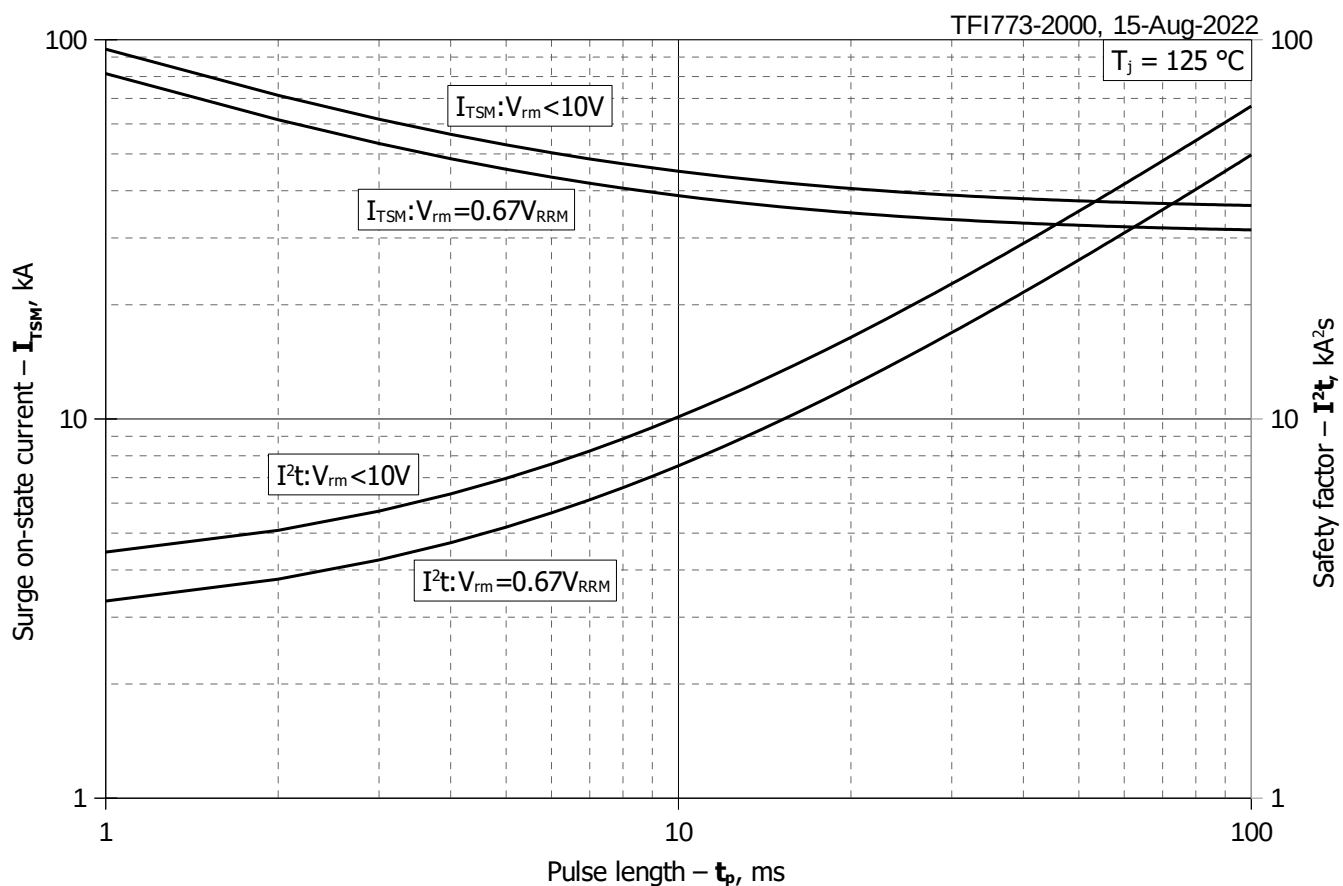


Fig 32 – Maximum surge on-state current I_{TSM} and safety factor I^2t vs. pulse length t_p

